



# DRV3203E-Q1 Three-Phase Brushless Motor Driver

*Not Recommended for New Designs*

## 1 Features

- Qualified for Automotive Applications
- AEC-Q100 Qualified with the Following Results:
  - Device Temperature Grade 0: –40°C to 150°C Ambient Operating Temperature Range
  - Device HBM ESD Classification Level H2
  - Device CDM ESD Classification Level C2
- 3-Phase Pre-Drivers for N-Channel MOS Field-Effect Transistors (MOSFETs)
- Pulse-Width Modulation (PWM) Frequency up to 20 kHz
- Fault Diagnostics
- Charge Pump
- Phase Comparators
- Microcontroller (MCU) Reset Generator
- Serial Port I/F (SPI)
- Motor-Current Sense
- 3.3-V Regulator
- Low-Current Sleep Mode
- Operation VB Range From 5.3 to 26.5 V
- 48-Pin PHP

## 2 Applications

- Automotive Motor-Control Applications
  - Oil Pump
  - Fuel Pump
  - Water Pump

## 3 Description

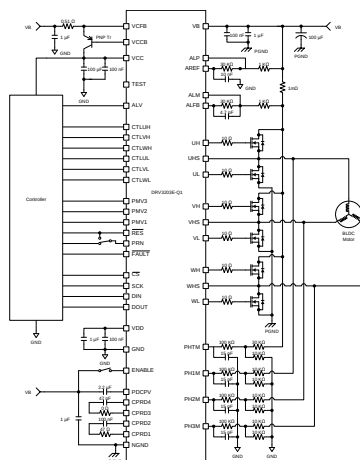
The DRV3203E-Q1 device is a field-effect transistor (FET) pre-driver designed for three-phase motor control for applications such as an oil pump or a water pump. The device has three high-side pre-FET drivers and three low-side drivers which are under the control of an external MCU. A charge pump supplies the power for the high side, and there is no requirement for a bootstrap capacitor. For commutation, this integrated circuit (IC) sends a conditional motor signal and output to the MCU. Diagnostics provide undervoltage, overvoltage, overcurrent, overtemperature and power-bridge faults. One can measure the motor current using an integrated current-sense amplifier and comparator in a battery common-mode range, which allows the use of the motor current in a high-side current-sense application. External resistors set the gain. One can configure the pre-drivers and other internal settings through the SPI.

### Device Information<sup>(1)</sup>

| PART NUMBER | PACKAGE    | BODY SIZE (NOM)   |
|-------------|------------|-------------------|
| DRV3203E-Q1 | HTQFP (48) | 7.00 mm × 7.00 mm |

(1) For all available packages, see the orderable addendum at the end of the datasheet.

### Typical Application Schematic



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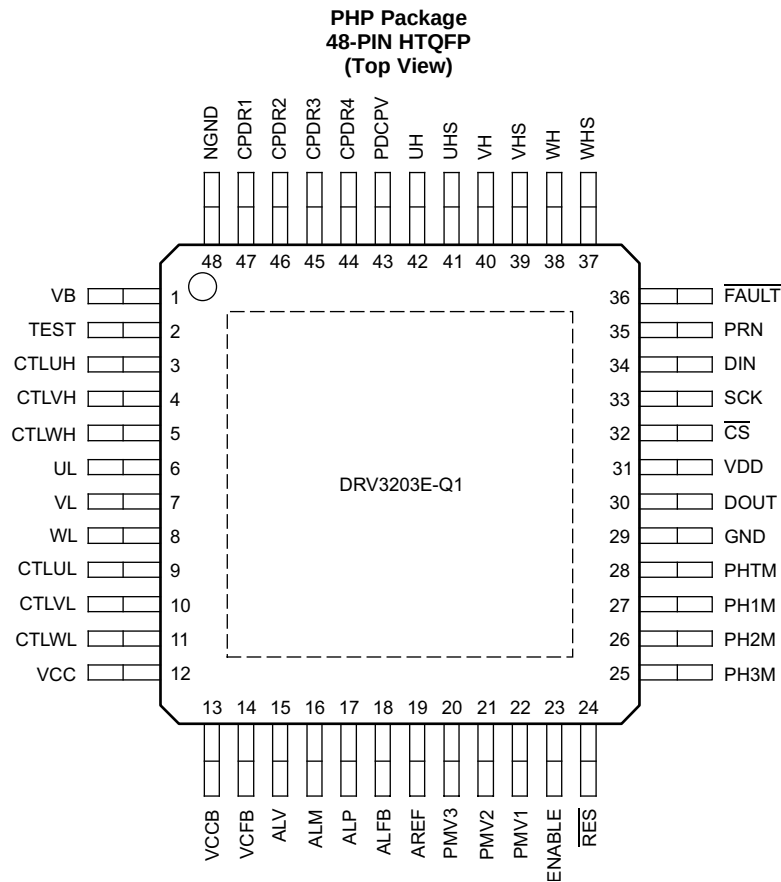
## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from Revision A (January 2014) to Revision B                                                                                                                                                                                                                                            | Page     |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|
| • Added <i>Pin Configuration and Functions</i> section, <i>ESD Ratings</i> table, <i>Feature Description</i> section, <i>Application and Implementation</i> section, <i>Device and Documentation Support</i> section, and <i>Mechanical, Packaging, and Orderable Information</i> section ..... | <b>1</b> |

| Changes from Original (November 2013) to Revision A                                                                                                                                                                 | Page      |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------|
| • Changed symbol for the Data delay time, SCK to DOUT parameter in the <i>SPI ELECTRICAL CHARACTERISTICS</i> table from $t_v$ to $t_d$ .....                                                                        | <b>5</b>  |
| • Changed the delay time, SCK to DOUT image reference from <a href="#">Figure 23</a> to <a href="#">Figure 2</a> in the <i>SPI ELECTRICAL CHARACTERISTICS</i> table .....                                           | <b>5</b>  |
| • Changed the max value for the RONH_HP parameter from 310 to 300 in the <i>Pre-Driver Electrical Characteristics</i> table ...                                                                                     | <b>7</b>  |
| • Deleted the 1 from the symbols for the time parameters ( $t_{on\_h}$ , $t_{off\_h}$ , $t_{h-on}$ , and $t_{h-off}$ ) for the high-side pre-driver in the <i>Pre-Driver Electrical Characteristics</i> table ..... | <b>7</b>  |
| • Changed the max for the VOL_L parameter from 55 to 60 in the <i>Pre-Driver Electrical Characteristics</i> table .....                                                                                             | <b>7</b>  |
| • Changed the max for the RONL_L parameter from 5 to 6 in the <i>Pre-Driver Electrical Characteristics</i> table .....                                                                                              | <b>7</b>  |
| • Changed the symbol for the turnoff time parameter for the low-side pre-driver from $t_{off\_h}$ to $t_{off\_l}$ in the <i>Pre-Driver Electrical Characteristics</i> table .....                                   | <b>7</b>  |
| • Changed conditions of Tset_TR2, Tset_TF2 and OVADth in the <i>Motor Current-Sense Electrical Characteristics</i> table .....                                                                                      | <b>9</b>  |
| • Changed the value for the VCCUVHYS parameters in the <i>VCC and VDD Electrical Characteristics</i> table from 50, 100, and 200 to 33, 66, and 132 .....                                                           | <b>9</b>  |
| • Added ADTH to the bit 6:4 description in the FLTCFG register table .....                                                                                                                                          | <b>26</b> |
| • Changed the description for writing a 0 to bit 2 in the FLTCFB register table from 2.3 to 2.2 V .....                                                                                                             | <b>26</b> |
| • Changed the dead time description for bit 1:0 in the PDCFG register table from 2, 1.5, 1, and 0.5 to 2.1, 1.6, 1.1, and 0.6 (respectively). Also changed the actual deadtime from $\pm 0.2$ to $\pm 0.1$ .....    | <b>30</b> |

## 5 Pin Configuration and Functions



### Pin Functions

| PIN             |     | TYPE | MAXIMUM<br>RATING | FUNCTION                                           |
|-----------------|-----|------|-------------------|----------------------------------------------------|
| NAME            | NO. |      |                   |                                                    |
| ALFB            | 18  | O    | –0.3 V to 40 V    | Motor current-sense amplifier feedback             |
| ALM             | 16  | I    | –0.3 V to 40 V    | Motor current- sense amplifier negative input      |
| ALP             | 17  | I    | –0.3 V to 40 V    | Motor current- sense amplifier positive input      |
| ALV             | 15  | O    | –0.3 V to 3.6 V   | Motor current- sense amplifier output              |
| AREF            | 19  | O    | –0.3 V to 40 V    | Reference output of motor current- sense amplifier |
| CPDR1           | 47  | O    | –0.3 V to 40 V    | Charge-pump output                                 |
| CPDR2           | 46  | O    | –0.3 V to 40 V    | Charge- pump output                                |
| CPDR3           | 45  | O    | –0.3 V to 40 V    | Charge- pump output                                |
| CPDR4           | 44  | O    | –0.3 V to 40 V    | Charge- pump output                                |
| $\overline{CS}$ | 32  | I    | –0.3 V to 3.6 V   | SPI chip select                                    |
| CTLUH           | 3   | I    | –0.3 V to 3.6 V   | Pre-driver parallel input                          |
| CTLUL           | 9   | I    | –0.3 V to 3.6 V   | Pre-driver parallel input                          |
| CTLVH           | 4   | I    | –0.3 V to 3.6 V   | Pre-driver parallel input                          |
| CTLVL           | 10  | I    | –0.3 V to 3.6 V   | Pre-driver parallel input                          |
| CTLWH           | 5   | I    | –0.3 V to 3.6 V   | Pre-driver parallel input                          |
| CTLWL           | 11  | I    | –0.3 V to 3.6 V   | Pre-driver parallel input                          |
| DIN             | 34  | I    | –0.3 V to 3.6 V   | SPI data input                                     |
| DOUT            | 30  | O    | –0.3 V to 3.6 V   | SPI data output                                    |

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**Pin Functions (continued)**

| PIN                       |     | TYPE | MAXIMUM<br>RATING | FUNCTION                                             |
|---------------------------|-----|------|-------------------|------------------------------------------------------|
| NAME                      | NO. |      |                   |                                                      |
| ENABLE                    | 23  | I    | –0.3 V to 40 V    | Enable input                                         |
| $\overline{\text{FAULT}}$ | 36  | O    | –0.3 V to 3.6 V   | Diagnosis output                                     |
| GND                       | 29  | I    | –0.3 V to 0.3 V   | GND                                                  |
| NGND                      | 48  | I    | –0.3 V to 0.3 V   | Power GND                                            |
| PDCPV                     | 43  | O    | –0.3 V to 40 V    | Charge pump output                                   |
| PH1M                      | 27  | I    | –1 V to 40 V      | Phase comparator input                               |
| PH2M                      | 26  | I    | –1 V to 40 V      | Phase comparator input                               |
| PH3M                      | 25  | I    | –1 V to 40 V      | Phase comparator input                               |
| PHTM                      | 28  | I    | –1 V to 40 V      | Phase comparator reference input                     |
| PMV1                      | 22  | O    | –0.3 V to 3.6 V   | Phase comparator output                              |
| PMV2                      | 21  | O    | –0.3 V to 3.6 V   | Phase comparator output                              |
| PMV3                      | 20  | O    | –0.3 V to 3.6 V   | Phase comparator output                              |
| PRN                       | 35  | I    | –0.3 V to 3.6 V   | Watchdog timer-pulse input                           |
| $\overline{\text{RES}}$   | 24  | O    | –0.3 V to 3.6 V   | MCU reset output                                     |
| SCK                       | 33  | I    | –0.3 V to 3.6 V   | SPI clock                                            |
| TEST                      | 2   | I    | –0.3 V to 20 V    | TEST input                                           |
| UH                        | 42  | O    | –5 V to 40 V      | Pre-driver output                                    |
| UHS                       | 41  | O    | –5 V to 40 V      | Pre-driver reference                                 |
| UL                        | 6   | O    | –0.3 V to 20 V    | Pre-driver output                                    |
| VB                        | 1   | I    | –0.3 V to 40 V    | VB input                                             |
| VCC                       | 12  | I    | –0.3 V to 3.6 V   | VCC supply input                                     |
| VCCB                      | 13  | O    | –0.3 V to 40 V    | VCC regulator base driver of PNP external transistor |
| VCFB                      | 14  | I    | –0.3 V to 40 V    | VCC regulator current-sense input                    |
| VDD                       | 31  | O    | –0.3 V to 3.6 V   | VDD supply output                                    |
| VH                        | 40  | O    | –5 V to 40 V      | Pre-driver output                                    |
| VHS                       | 39  | O    | –5 V to 40 V      | Pre-driver reference                                 |
| VL                        | 7   | O    | –0.3 V to 20 V    | Pre-driver output                                    |
| WH                        | 38  | O    | –5 V to 40 V      | Pre-driver output                                    |
| WHS                       | 37  | O    | –5 V to 40 V      | Pre-driver reference                                 |
| WL                        | 8   | O    | –0.3 V to 20 V    | Pre-driver output                                    |

**6 Specifications****6.1 Absolute Maximum Ratings**

over operating free-air temperature range (unless otherwise noted)

|                                            | MIN | MAX | UNIT |
|--------------------------------------------|-----|-----|------|
| T <sub>A</sub> Operating temperature range | –40 | 150 | °C   |
| T <sub>J</sub> Junction temperature        | –40 | 175 | °C   |
| T <sub>stg</sub> Storage temperature       | –55 | 175 | °C   |

**6.2 ESD Ratings**

|                                            | VALUE                                                   | UNIT  |
|--------------------------------------------|---------------------------------------------------------|-------|
| V <sub>(ESD)</sub> Electrostatic discharge | Human-body model (HBM), per AEC Q100-002 <sup>(1)</sup> | ±2000 |
|                                            | Charged-device model (CDM), per AEC Q100-011            | ±500  |

(1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

### 6.3 Thermal Information

| THERMAL METRIC    |                                              | DRV3203E-Q1 | UNIT |
|-------------------|----------------------------------------------|-------------|------|
|                   |                                              | PHP (HTQFP) |      |
|                   |                                              | 48 PINS     |      |
| $\theta_{JA}$     | Junction-to-ambient thermal resistance       | 26.1        | °C/W |
| $\theta_{JCTop}$  | Junction-to-case (top) thermal resistance    | 11.5        | °C/W |
| $\theta_{JB}$     | Junction-to-board thermal resistance         | 7.2         | °C/W |
| $\psi_{JT}$       | Junction-to-top characterization parameter   | 0.2         | °C/W |
| $\psi_{JB}$       | Junction-to-board characterization parameter | 7.1         | °C/W |
| $\theta_{JCbott}$ | Junction-to-case (bottom) thermal resistance | 0.4         | °C/W |

### 6.4 Electrical Characteristics

$V_B = 12\text{ V}$ ,  $T_A = -40^\circ\text{C}$  to  $+150^\circ\text{C}$  (unless otherwise specified)

| PARAMETER                        |                                                    | TEST CONDITIONS                                                       | MIN      | TYP      | MAX | UNIT |
|----------------------------------|----------------------------------------------------|-----------------------------------------------------------------------|----------|----------|-----|------|
| WATCHDOG                         |                                                    |                                                                       |          |          |     |      |
| VSTN <sup>(1)</sup>              | Function start VCC voltage $\overline{\text{RES}}$ | See Figure 1                                                          | -        | 0.8      | 1.3 | V    |
| t <sub>ON</sub> <sup>(1)</sup>   | Power-on time $\overline{\text{RES}}$              |                                                                       | 2.5      | 3        | 3.5 | ms   |
| t <sub>OFF</sub> <sup>(1)</sup>  | Clock-off reset time $\overline{\text{RES}}$       |                                                                       | 64       | 80       | 96  | ms   |
| t <sub>RL</sub> <sup>(1)</sup>   | Reset-pulse low time $\overline{\text{RES}}$       |                                                                       | 16       | 20       | 24  | ms   |
| t <sub>RH</sub> <sup>(1)</sup>   | Reset-pulse high time $\overline{\text{RES}}$      |                                                                       | 64       | 80       | 96  | ms   |
| t <sub>RES</sub> <sup>(1)</sup>  | Reset delay time $\overline{\text{RES}}$           |                                                                       | 30       | 71.5     | 90  | μs   |
| P <sub>wth</sub> <sup>(1)</sup>  | Pulse duration PRN                                 |                                                                       | 2        | -        | -   | μs   |
| SPI                              |                                                    |                                                                       |          |          |     |      |
| f <sub>op</sub>                  | SPI clock frequency                                |                                                                       | -        | -        | 4   | MHz  |
| t <sub>lead</sub> <sup>(1)</sup> | Enable lead time                                   |                                                                       | 200      | -        | -   | ns   |
| t <sub>wait</sub> <sup>(1)</sup> | Wait time between two successive communications    |                                                                       | 5        | -        | -   | μs   |
| t <sub>lag</sub> <sup>(1)</sup>  | Enable lag time                                    |                                                                       | 100      | -        | -   | ns   |
| t <sub>pw</sub> <sup>(1)</sup>   | SCLK pulse duration                                |                                                                       | 100      | -        | -   | ns   |
| t <sub>su</sub> <sup>(1)</sup>   | Data setup time                                    |                                                                       | 100      | -        | -   | ns   |
| t <sub>h</sub> <sup>(1)</sup>    | Data hold time                                     |                                                                       | 100      | -        | -   | ns   |
| t <sub>dis</sub> <sup>(1)</sup>  | Data-output disable time                           |                                                                       | -        | -        | 200 | ns   |
| t <sub>en</sub> <sup>(1)</sup>   | Data-output enable time                            |                                                                       | -        | -        | 100 | ns   |
| t <sub>d</sub> <sup>(1)</sup>    | Data delay time, SCK to DOUT                       | C <sub>L</sub> = 50 pF, see Figure 2.                                 | 0        | -        | 100 | ns   |
| CHARGE PUMP                      |                                                    |                                                                       |          |          |     |      |
| Vchv1_0                          | Output voltage, PDCPV                              | VB = 5.3 V, load = 0 mA, C1 = C2 = 47 nF, CCP = 2.2 μF, R1 = R2 = 0 Ω | VB + 7   | VB + 8   | -   | V    |
| Vchv1_1                          | Output voltage, PDCPV                              | VB = 5.3 V, load = 5 mA, C1 = C2 = 47 nF, CCP = 2.2 μF, R1 = R2 = 0 Ω | VB + 5.5 | VB + 6.5 | -   | V    |
| Vchv1_2                          | Output voltage, PDCPV                              | VB = 5.3 V, load = 8 mA, C1 = C2 = 47 nF, CCP = 2.2 μF, R1 = R2 = 0 Ω | VB + 4.5 | VB + 5.5 | -   | V    |

(1) Specified by design.

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VB = 12 V, TA = –40°C to +150°C (unless otherwise specified)

| PARAMETER                       |                                  | TEST CONDITIONS                                                             | MIN      | TYP       | MAX       | UNIT |
|---------------------------------|----------------------------------|-----------------------------------------------------------------------------|----------|-----------|-----------|------|
| Vchv2_0                         | Output voltage, PDCPV            | VB = 12 V, load = 0 mA, C1 = C2 = 47 nF, CCP = 2.2 µF, R1 = R2 = 0 Ω        | VB + 10  | VB + 12   | VB + 14   | V    |
| Vchv2_1                         | Output voltage, PDCPV            | VB = 12 V, load = 11 mA, C1 = C2 = 47 nF, CCP = 2.2 µF, R1 = R2 = 0 Ω       | VB + 9.5 | VB + 11.5 | VB + 13.5 | V    |
| Vchv2_2                         | Output voltage, PDCPV            | VB = 12 V, load = 18 mA, C1 = C2 = 47 nF, CCP = 2.2 µF, R1 = R2 = 0 Ω       | VB + 9   | VB + 11   | VB + 13   | V    |
| Vchv3_0                         | Output voltage, PDCPV            | VB = 18 V, load = 0 mA, C1 = C2 = 47 nF, CCP = 2.2 µF, R1 = R2 = 0 Ω        | VB + 10  | VB + 12   | VB + 14   | V    |
| Vchv3_1                         | Output voltage, PDCPV            | VB = 18 V, load = 13 mA, C1 = C2 = 47 nF, CCP = 2.2 µF, R1 = R2 = 0 Ω       | VB + 10  | VB + 12   | VB + 14   | V    |
| Vchv3_2                         | Output voltage, PDCPV            | VB = 18 V, load = 22 mA, C1 = C2 = 47 nF, CCP = 2.2 µF, R1 = R2 = 0 Ω       | VB + 10  | VB + 12   | VB + 14   | V    |
| VchvOV                          | Overvoltage detection threshold  |                                                                             | 35       | 37.5      | 40        | V    |
| VchvUV                          | Undervoltage detection threshold |                                                                             | VB + 4   | VB + 4.5  | VB + 5    | V    |
| t <sub>chv</sub> <sup>(1)</sup> | Rise time                        | VB = 5.3 V, C1 = C2 = 47 nF, CCP = 2.2 µF, R1 = R2 = 0 Ω, Vchv, UV released |          | 1         | 2         | ms   |
| Ron                             | On-resistance, S1-S4             | See <a href="#">Figure 10</a>                                               |          | 8         |           | Ω    |

## Electrical Characteristics (continued)

$V_B = 12\text{ V}$ ,  $T_A = -40^\circ\text{C}$  to  $+150^\circ\text{C}$  (unless otherwise specified)

| PARAMETER                   |                                           | TEST CONDITIONS                                                                                                                   | MIN  | TYP  | MAX | UNIT     |
|-----------------------------|-------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------|------|------|-----|----------|
| <b>HIGH-SIDE PRE-DRIVER</b> |                                           |                                                                                                                                   |      |      |     |          |
| VOH_H                       | Output voltage, turnon side               | Isink = 10 mA, PDCPV - xH                                                                                                         |      | 1.35 | 2.7 | V        |
| VOL_H                       | Output voltage, turnoff side              | Isource = 10 mA, xH - xHS                                                                                                         |      | 25   | 50  | mV       |
| RONH_HP                     | On-resistance, turnon side (Pch)          | $U(V/W)_H = \text{PDCPV} - 1\text{ V}$                                                                                            |      | 135  | 300 | $\Omega$ |
| RONH_HN                     | On-resistance, turnon side (Nch)          | $U(V/W)_H = \text{PDCPV} - 2.5\text{ V}$                                                                                          |      | 4    | 8   | $\Omega$ |
| RONL_H                      | On-resistance turnoff side                |                                                                                                                                   |      | 2.5  | 5   | $\Omega$ |
| $t_{on\_h}^{(1)}$           | Turnon time                               | $C_L = 12\text{ nF}$ , $R_L = 0\ \Omega$ from 20% to 80%                                                                          | 50   | -    | 200 | ns       |
| $t_{off\_h}^{(1)}$          | Turnoff time                              | $C_L = 12\text{ nF}$ , $R_L = 0\ \Omega$ from 80% to 20%                                                                          | 50   | -    | 200 | ns       |
| $t_{h\_ondly}^{(1)}$        | Output delay time                         | $C_L = 12\text{ nF}$ , $R_L = 0\ \Omega$ to 20%, no dead time                                                                     | -    | 200  | -   | ns       |
| $t_{h\_offdly}^{(1)}$       | Output delay time                         | $C_L = 12\text{ nF}$ , $R_L = 0\ \Omega$ to 80%, no dead time                                                                     | -    | 200  | -   | ns       |
| VGS_hs                      | Gate-source high -side voltage difference | xH-xHS                                                                                                                            | -0.3 |      | 18  | V        |
| <b>LOW-SIDE PRE-DRIVER</b>  |                                           |                                                                                                                                   |      |      |     |          |
| VOH_L1                      | Output voltage, turnon side               | $V_B = 12\text{ V}$ , Isink = 10 mA, xL -NGND                                                                                     | 10   | 12   | 14  | V        |
| VOH_L2                      | Output voltage, turnon side               | $V_B = 5.3\text{ V}$ , Isink = 10 mA, xL - NGND                                                                                   | 5.5  | 7.5  | 10  | V        |
| VOL_L                       | Output voltage, turnoff side              | Isource = 10 mA, xL - NGND                                                                                                        | -    | 25   | 60  | mV       |
| RONH_L                      | On-resistance, turnon side                |                                                                                                                                   | -    | 6    | 12  | $\Omega$ |
| RONL_L                      | On-resistance, turnoff side               |                                                                                                                                   |      | 2.5  | 6   | $\Omega$ |
| $t_{on\_l}^{(1)}$           | Turnon time                               | $C_L = 18\text{ nF}$ , $R_L = 0\ \Omega$ , from 20% to 80% of 12 V, from 20% to 80% of 6 V ( $V_B = 5.3\text{ V}$ )               | 50   | -    | 200 | ns       |
| $t_{off\_l}^{(1)}$          | Turnoff time                              | $C_L = 18\text{ nF}$ , $R_L = 0\ \Omega$ , from 80% to 20% of 12 V, from 80% to 20% of 6 V ( $V_B = 5.3\text{ V}$ )               | 50   | -    | 200 | ns       |
| $t_{l\_ondly}^{(1)}$        | Output delay time                         | $C_L = 18\text{ nF}$ , $R_L = 0\ \Omega$ , to 20% of 12 V, to 20% of $V_{OH} = 6\text{ V}$ ( $V_B = 5.3\text{ V}$ ), no dead time | -    | 200  | -   | ns       |
| $t_{l\_offdly}^{(1)}$       | Output delay time                         | $C_L = 18\text{ nF}$ , $R_L = 0\ \Omega$ , to 80% of 12 V, to 80% of $V_{OH} = 6\text{ V}$ ( $V_B = 5.3\text{ V}$ ), no dead time | -    | 200  | -   | ns       |
| $t_{diff1}^{(1)}$           | Differential time1                        | (Th-on) - (Tl-off), no dead time, See Figure 3                                                                                    | -200 | 0    | 200 | ns       |

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**Electrical Characteristics (continued)**

VB = 12 V, TA = –40°C to +150°C (unless otherwise specified)

| PARAMETER                  |                               | TEST CONDITIONS                                                                                                     | MIN                  | TYP             | MAX                      | UNIT |
|----------------------------|-------------------------------|---------------------------------------------------------------------------------------------------------------------|----------------------|-----------------|--------------------------|------|
| $t_{diff2}^{(1)}$          | Differential time2            | (TI-on) - (TI-off), no dead time, See Figure 3                                                                      | –200                 | 0               | 200                      | ns   |
| $t_{dead}^{(1)}$           | Dead time                     | OSC1 = 10 MHz SPI register PDCFG.DEADT                                                                              | 2<br>1.5<br>1<br>0.5 |                 | 2.2<br>1.7<br>1.2<br>0.7 | μs   |
| <b>PHASE COMPARTOR</b>     |                               |                                                                                                                     |                      |                 |                          |      |
| V <sub>IOfs</sub>          | Input offset voltage          |                                                                                                                     | –15                  | -               | 15                       | mV   |
| V <sub>Im1</sub>           | Input voltage range, PHTM     | VB = 6 V – 26.5 V                                                                                                   | 1.3                  | -               | 4.5                      | V    |
| V <sub>Im2</sub>           | Input voltage range, PHTM     | VB = 5.3 V                                                                                                          | 1.3                  | -               | 4.2                      | V    |
| V <sub>Ip</sub>            | Input voltage range, PHxM     |                                                                                                                     | –1                   | -               | VB                       | V    |
| V <sub>hys</sub>           | Threshold hysteresis voltage  | SPI register SPARE. SEL_COMP_HYS                                                                                    | -                    | 0               | -                        | mV   |
| 12.5                       | 25                            | 50                                                                                                                  |                      |                 |                          |      |
| 25                         | 50                            | 100                                                                                                                 |                      |                 |                          |      |
| 50                         | 100                           | 200                                                                                                                 |                      |                 |                          |      |
| V <sub>OH</sub>            | Output high voltage           | Isink = 2.5 mA                                                                                                      | 0.9 × VCC            | -               | -                        | V    |
| V <sub>OL</sub>            | Output low voltage            | Isource = 2.5 mA                                                                                                    | -                    | -               | 0.1 × VCC                | V    |
| $t_{res\_tr}^{(1)}$        | Response time, rising         | C <sub>L</sub> = 100 pF                                                                                             | -                    | 0.7             | 1.5                      | μs   |
| $t_{res\_tf}^{(1)}$        | Response time, falling        | C <sub>L</sub> = 100 pF                                                                                             | -                    | 0.7             | 1.5                      | μs   |
| <b>MOTOR CURRENT SENSE</b> |                               |                                                                                                                     |                      |                 |                          |      |
| V <sub>Ofs</sub>           | Input offset voltage          |                                                                                                                     | –5                   |                 | 5                        | mV   |
| V <sub>O_0</sub>           | Output voltage, ALV           | Imotor = 0 A, SPI register CSCFG. CSOFFSET                                                                          | -                    | 0.5<br>1<br>1.5 | -                        | V    |
| V <sub>Line</sub>          | Linearity, ALV                | Rshunt = 1 mΩ, R11 = R12 = 1 kΩ, R21 = R22 = 30 kΩ                                                                  | 29.4                 | 30              | 30.6                     | mV/A |
| V <sub>Gain</sub>          | Gain                          |                                                                                                                     | 10                   | 30              | -                        | V/V  |
| Tset_TR1 <sup>(1)</sup>    | Settling time (rise), ALV ±1% | Rshunt = 1 mΩ, V <sub>Gain</sub> = 30, C <sub>L</sub> = 100 pF, Imotor = 0 A → 30 A, (ALV: 1 V → 1.9 V, AREF = 1 V) | -                    | 1               | 2.5                      | μs   |
| Tset_TR2 <sup>(1)</sup>    | Settling time(rise), ALV ±1%  | Rshunt = 1 mΩ, V <sub>Gain</sub> = 30, C <sub>L</sub> = 100 pF, Imotor = 0 A → 60 A, (ALV: 1 V → 2.8 V, AREF = 1 V) | -                    | 1               | 2.5                      | μs   |
| Tset_TF1 <sup>(1)</sup>    | Settling time(fall), ALV ±1%  | Rshunt = 1 mΩ, V <sub>Gain</sub> = 30, C <sub>L</sub> = 100 pF, Imotor = 30 A → 0, (ALV: 1.9 V → 1 V, AREF = 1 V)   | -                    | 1               | 2.5                      | μs   |



## Electrical Characteristics (continued)

VB = 12 V, TA = –40°C to +150°C (unless otherwise specified)

| PARAMETER                |                                              | TEST CONDITIONS                                                                                                                                        | MIN                          | TYP                  | MAX                          | UNIT |
|--------------------------|----------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------|----------------------|------------------------------|------|
| Tset_TF2 <sup>(1)</sup>  | Settling time(fall), ALV ±1%                 | Rshunt = 1 mΩ,<br>VGain = 30, CL =<br>100 pF,<br>Imotor = 60 A → 0,<br>(ALV: 2.8 V → 1 V,<br>AREF = 1 V)                                               | -                            | 1                    | 2.5                          | μs   |
| OVADth                   | Overcurrent threshold                        | Rshunt = 1 mΩ,<br>VGain = 30, AREF =<br>1 V, ADTH = 1.98 V,<br>SPI register<br>FLTCFG. MTOCTH,<br>OVADth = (2 ×<br>ADTH -- AREF) /<br>(Rshunt × VGain) | 89.1                         | 99                   | 108.9                        | A    |
| TDEL_OVAD <sup>(1)</sup> | Propagation delay<br>(rise or fall)          |                                                                                                                                                        | -                            | -                    | 1.5                          | μs   |
| tfiltMTOC                | filtering time                               | OSC1 = 9 MHz-11<br>MHz                                                                                                                                 | 0.8                          | 1                    | 1.2                          | μs   |
| <b>VCC</b>               |                                              |                                                                                                                                                        |                              |                      |                              |      |
| VCC1                     | Output Voltage                               |                                                                                                                                                        | 3.23                         | 3.3                  | 3.37                         | V    |
| IBVCC                    | Base Current                                 |                                                                                                                                                        | 2                            |                      |                              | mA   |
| hfePNP                   | DC current gain of external PNP              |                                                                                                                                                        | 100                          | -                    | -                            |      |
| VLRVCC                   | Load regulation                              | ILVCC = 5 mA to<br>200 mA                                                                                                                              | -20                          | -                    | 20                           | mV   |
| CVCC                     | External Capacitance                         |                                                                                                                                                        | 22                           |                      | 100                          | μF   |
| RVCC                     | ESR of external Capacitor                    |                                                                                                                                                        |                              |                      | 300                          | mΩ   |
| VCCUV                    | Under voltage detection threshold            | SPI register<br>FLTCFG. VCCUVTH                                                                                                                        | 2<br>2.2                     | 2.2<br>2.4           | 2.4<br>2.6                   | V    |
| VCCUVHYS                 | Under voltage detection threshold hysteresis |                                                                                                                                                        | 33                           | 66                   | 132                          | mV   |
| VCCOV                    | Overvoltage detection threshold              |                                                                                                                                                        | 3.5                          | 3.8                  | 4.1                          | V    |
| VCCOC                    | Current Limit                                | Rsns = 0.51 Ω, 0.2<br>V = Rsns × VCCOC                                                                                                                 | 300                          | 400                  | 550                          | mA   |
| Tvcc1 <sup>(1)</sup>     | Rise Time                                    | VCC > VCCUV,<br>CVCC = 22 μF                                                                                                                           |                              |                      | 0.5                          | ms   |
| Tvcc2 <sup>(1)</sup>     | Rise Time                                    | VCC > VCCUV,<br>CVCC = 100 μF                                                                                                                          |                              |                      | 1.5                          | ms   |
| <b>VDD</b>               |                                              |                                                                                                                                                        |                              |                      |                              |      |
| VDD                      | Output Voltage                               |                                                                                                                                                        | 3                            | 3.3                  | 3.6                          | V    |
| CVDD                     | Load Capacitance                             |                                                                                                                                                        |                              | 1                    |                              | μF   |
| VDDUV                    | Under voltage detection threshold            |                                                                                                                                                        | 2.1                          | 2.3                  | 2.5                          | V    |
| VDDOV                    | Overvoltage detection threshold              |                                                                                                                                                        | 4                            | 4.3                  | 4.6                          | V    |
| Tvdd <sup>(1)</sup>      | Rise Time                                    | VDD > VDDUV,<br>CVDD = 1 μF                                                                                                                            |                              |                      | 100                          | μs   |
| <b>VB MONITOR</b>        |                                              |                                                                                                                                                        |                              |                      |                              |      |
| VBOV                     | VB overvoltage detection threshold level     |                                                                                                                                                        | 26.5                         | 27.5                 | 28.5                         | V    |
| VBUV                     | VB Undervoltage detection threshold level    | SPI register<br>FLTCFG. VBUVTH                                                                                                                         | 3.65<br>4.15<br>4.65<br>5.15 | 4<br>4.5<br>5<br>5.5 | 4.35<br>4.85<br>5.35<br>5.85 | V    |
| <b>THERMAL SHUT DOWN</b> |                                              |                                                                                                                                                        |                              |                      |                              |      |
| TSD <sup>(1)</sup>       | Thermal shut down threshold level            |                                                                                                                                                        | 155                          | 175                  | 195                          | °C   |
| TSDhys <sup>(1)</sup>    | Thermal shut down hysteresis                 |                                                                                                                                                        | 5                            | 10                   | 15                           | °C   |

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**Electrical Characteristics (continued)**VB = 12 V, T<sub>A</sub> = –40°C to +150°C (unless otherwise specified)

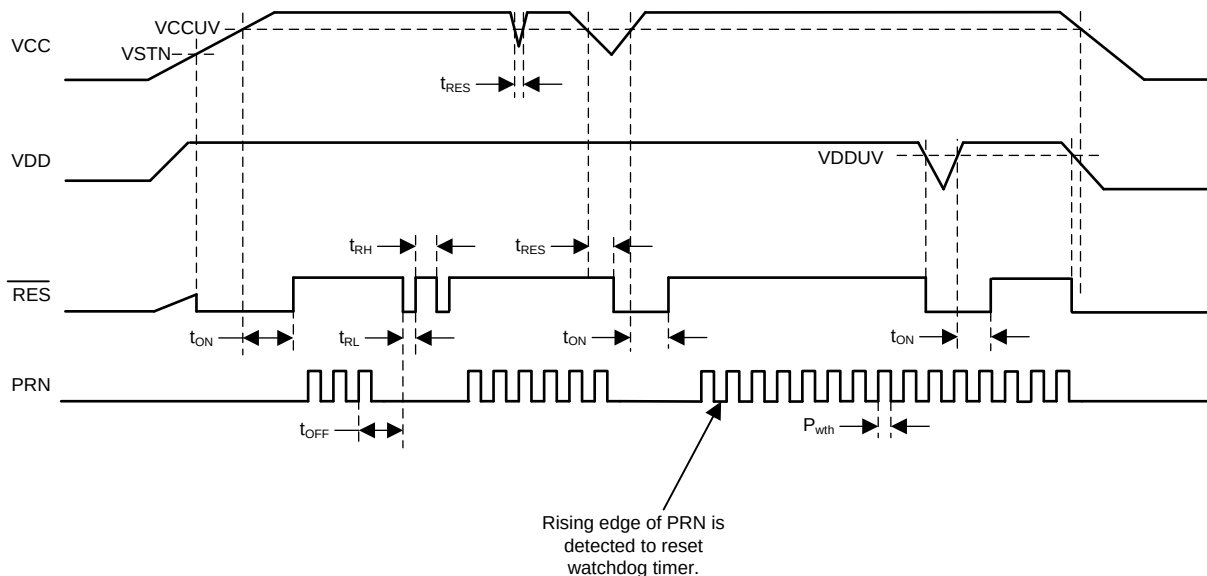
| PARAMETER                        |                                     | TEST CONDITIONS            | MIN       | TYP       | MAX | UNIT |
|----------------------------------|-------------------------------------|----------------------------|-----------|-----------|-----|------|
| <b>OSCILLATOR</b>                |                                     |                            |           |           |     |      |
| OSC1                             | OSC1 frequency                      |                            | 9         | 10        | 11  | MHz  |
| OSC2                             | OSC2 frequency                      |                            |           | 10        |     | MHz  |
| <b>INPUT BUFFER1</b>             |                                     |                            |           |           |     |      |
| V <sub>IH</sub>                  | Input threshold logic high          |                            | 0.7 × VCC |           |     | V    |
| V <sub>IL</sub>                  | Input threshold logic low           |                            |           | 0.3 × VCC |     | V    |
| R <sub>u</sub> or R <sub>d</sub> | Input pullup or pulldown resistance |                            | 50        | 100       | 150 | kΩ   |
| <b>OUTPUT BUFFER1(2)</b>         |                                     |                            |           |           |     |      |
| V <sub>OH</sub>                  | Output level logic high             | I <sub>sink</sub> = 1 mA   | 0.9 × VCC |           |     | V    |
| V <sub>OL</sub>                  | Output level logic low              | I <sub>source</sub> = 1 mA |           | 0.1 × VCC |     | V    |
| <b>OUTPUT BUFFER3</b>            |                                     |                            |           |           |     |      |
| R <sub>RES</sub>                 | Pull up Resistor                    |                            | 2         | 3         | 4   | kΩ   |
| V <sub>OL</sub>                  | Output level logic low              | I <sub>source</sub> = 2 mA |           | 0.1 × VCC |     | V    |

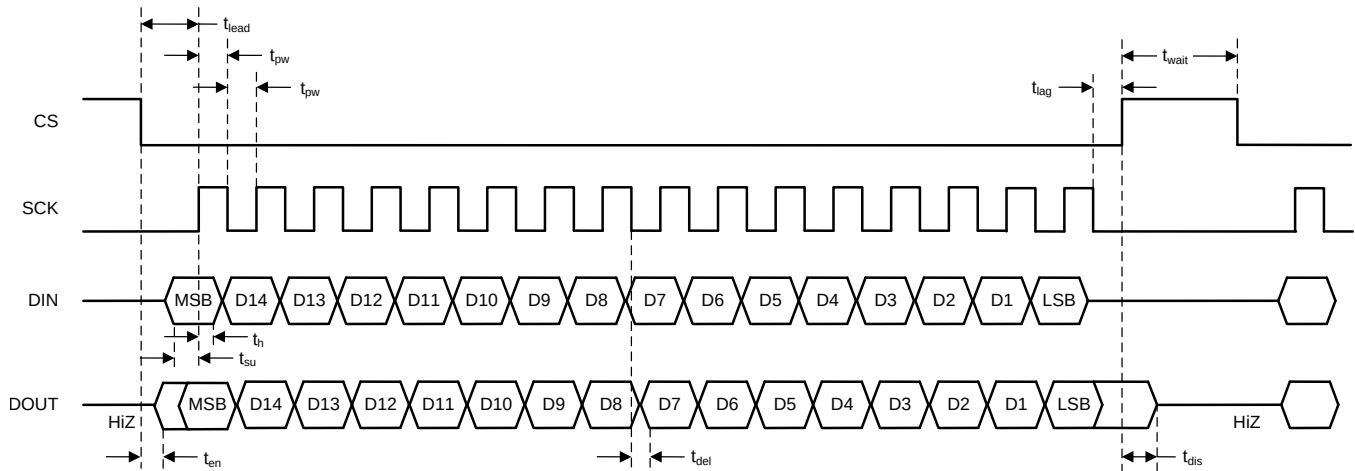
**6.5 Supply Voltage and Current**VB = 12 V, T<sub>A</sub> = –40°C to +150°C (unless otherwise specified)

| PARAMETER           |                                     | TEST CONDITIONS           | MIN | TYP | MAX  | UNITS |
|---------------------|-------------------------------------|---------------------------|-----|-----|------|-------|
| <b>SUPPLY INPUT</b> |                                     |                           |     |     |      |       |
| VB1 <sup>(1)</sup>  | VB supply voltage (motor operation) | Full device functionality | 5.3 | 12  | 18   | V     |
| VB2 <sup>(1)</sup>  | VB supply voltage (MCU operation)   | Full device functionality | 4.5 | 12  | 18   | V     |
| VB3 <sup>(2)</sup>  | VB supply voltage                   |                           | 18  | -   | 26.5 | V     |
| I <sub>vb</sub>     | VB operating current                | ENABLE = High, no PWM     | -   | 18  | 27   | mA    |
| I <sub>vbq</sub>    | VB quiescent current                | ENABLE = Low              | -   | 50  | 100  | μA    |

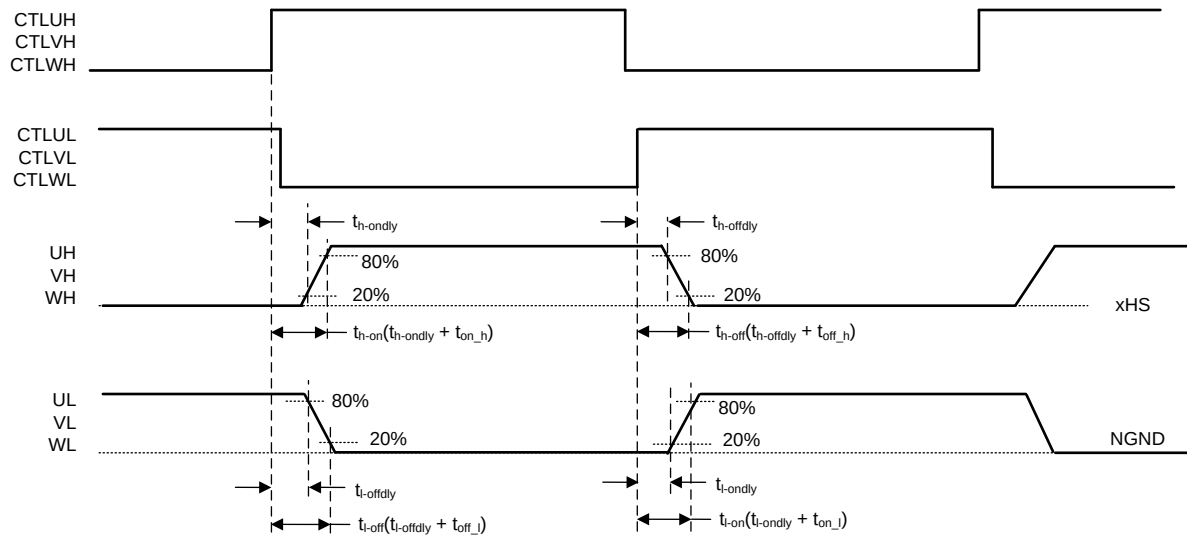
(1) Performance of supply voltage 5.3 to 18 V is according to the ACE-Q100 (Grade 0) standard.

(2) Specified by design.

NOTE: VCC undervoltage condition sets  $\overline{\text{RES}}$  = Low.**Figure 1. Watchdog Timing Chart**



**Figure 2. SPI Timing Diagram**



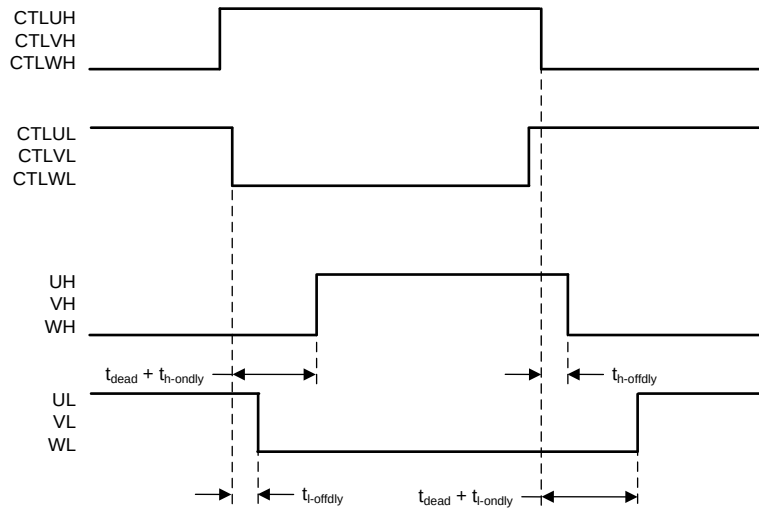
NOTE: This diagram excludes dead time to explain the timing parameters of the pre-driver.

**Figure 3. Delay Time From Input to Output**

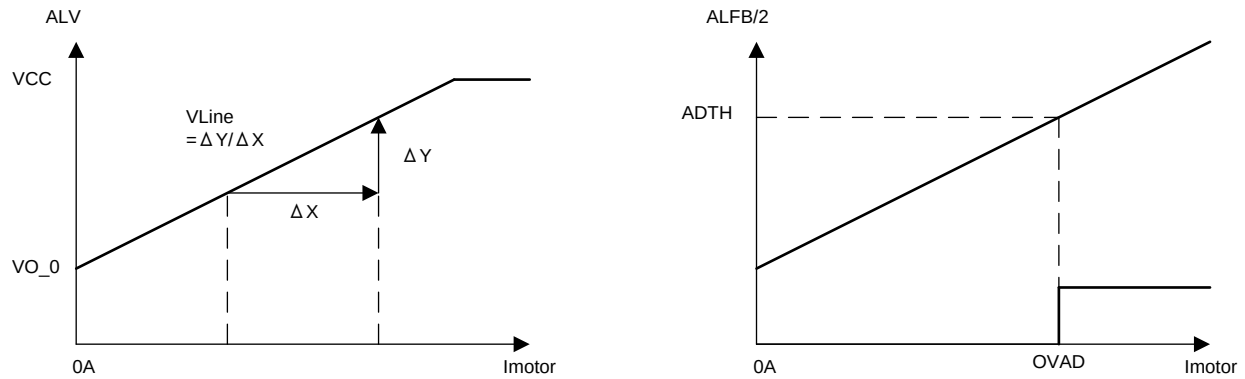
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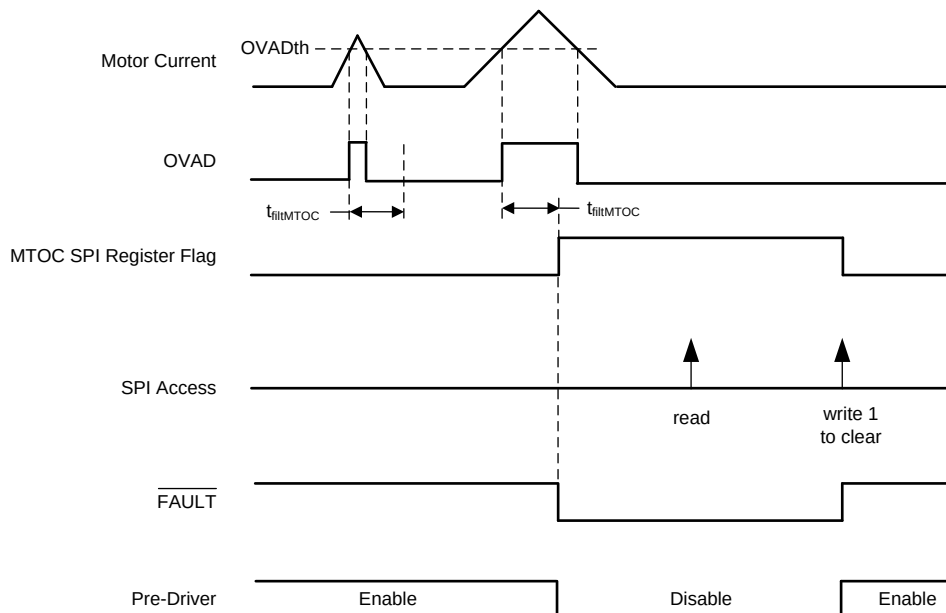
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**Figure 4. Dead Time**

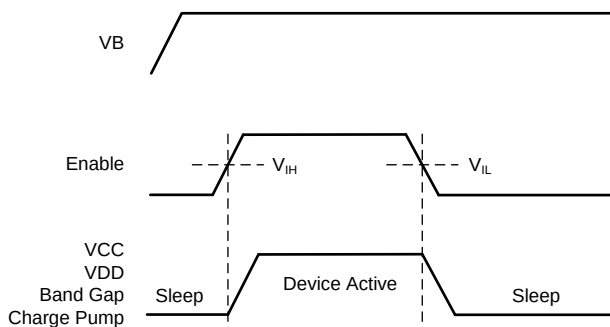


**Figure 5. Motor Current Sense and Overcurrent**



- (1) MCU must set the FLTCFG.FLGLATCH\_EN bit to 1 to get the latch-type operation shown in this figure.
- (2) When MTOC condition is detected,  $\overline{\text{FAULT}}$  is asserted to low if FE\_MTOC bit is 1.
- (3) When MTOC condition is detected, Pre Driver is disabled if SE\_MTOC is 1.

**Figure 6. Motor Overcurrent Event**



**Figure 7. I/O ENABLE Timing Chart**

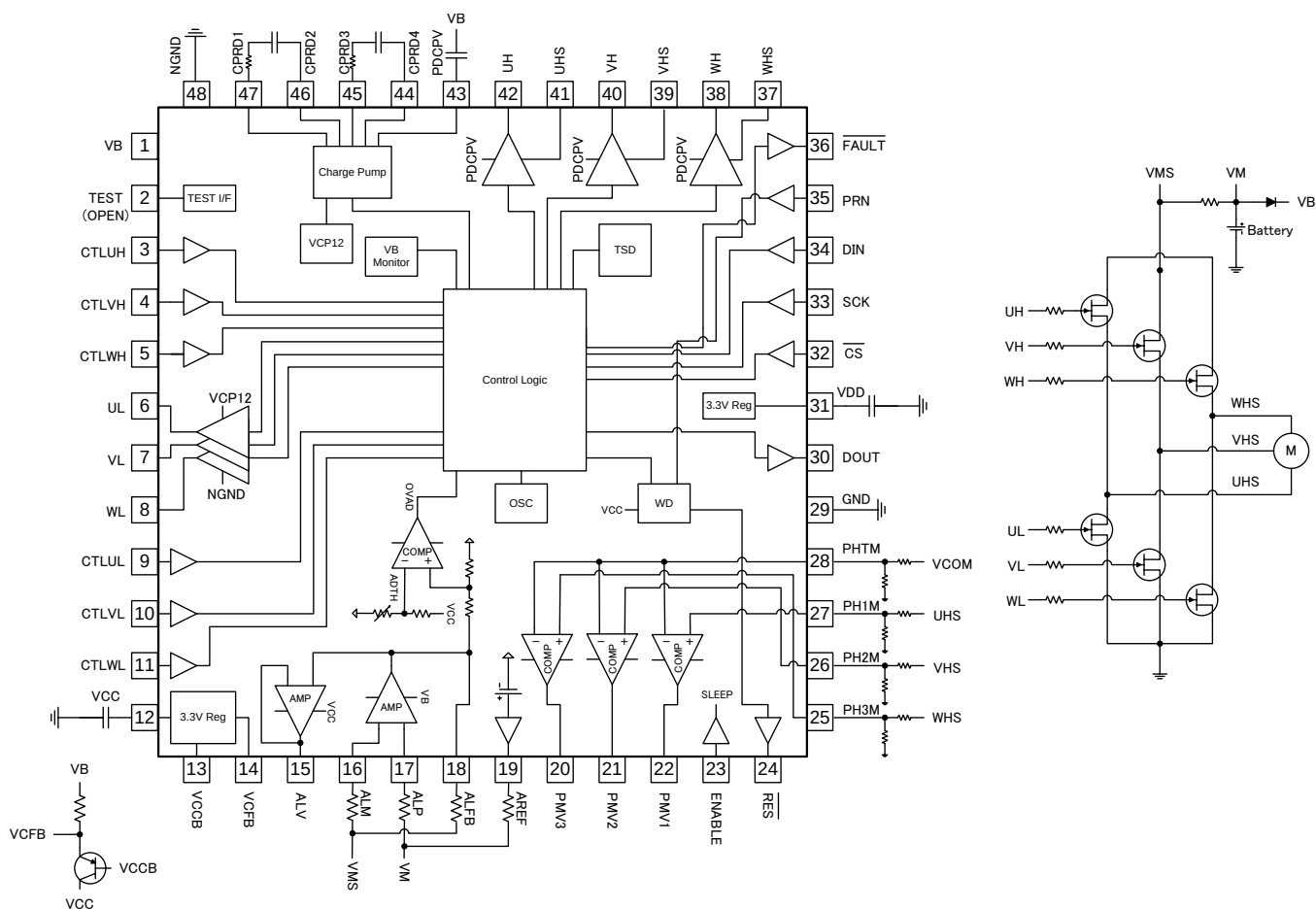
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## 7 Detailed Description

### 7.1 Functional Block Diagram

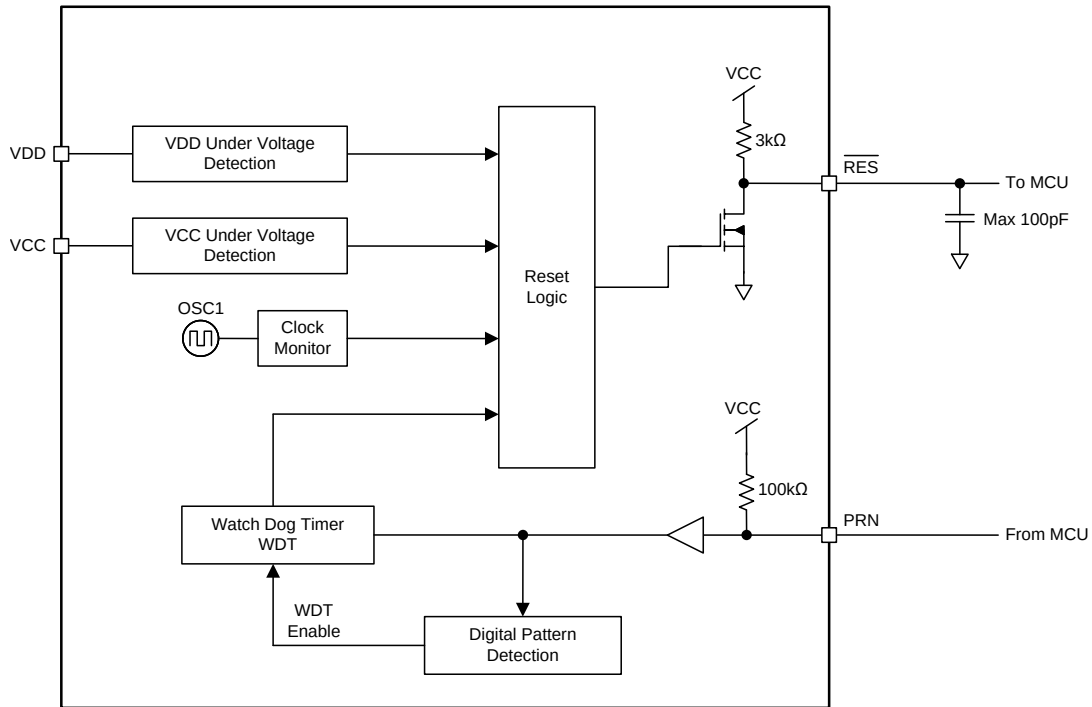


### 7.2 Feature Description

#### 7.2.1 Watchdog

A watchdog monitors the PRN signal and VCC supply level and generates a reset to the MCU through the  $\overline{\text{RES}}$  pin if the status of PRN is not normal or VCC is lower than the specified threshold level. Detection of a special pattern on the PRN input during power up can disable the watchdog.

## Feature Description (continued)



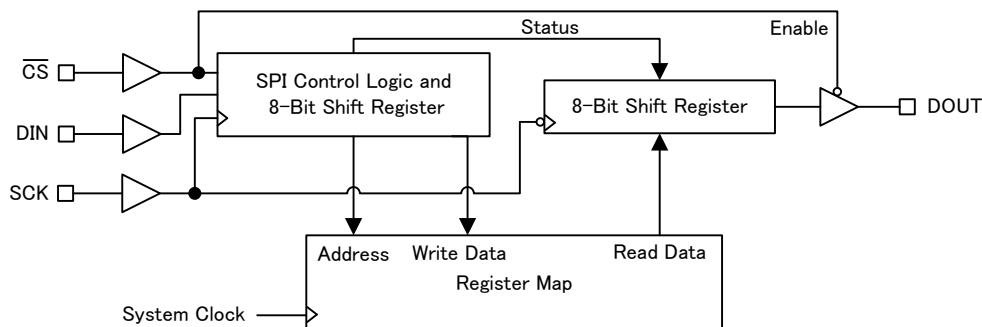
**Figure 8. Watchdog Block Diagram**

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[www.ti.com](http://www.ti.com)**Feature Description (continued)****7.2.2 Serial Port I/F**

Setting device configuration and reading out diagnostic information is via SPI. SPI operates in slave mode. SPI uses four signals according to the timing chart of [Figure 2](#).

**Figure 9. Block Diagram of SPI****7.2.2.1  $\overline{CS}$  - Chip Select**

The MCU uses  $\overline{CS}$  to select the IC.  $\overline{CS}$  is normally high, and communication is possible only when it is forced low. When  $\overline{CS}$  falls, communication between the IC and the MCU starts. The transmitted data are latched and the DOUT output pin leaves high impedance. When  $\overline{CS}$  rises, communication stops. The DOUT output pin goes into high impedance. The next falling edge starts another communication. There is a minimum waiting time between the two communications ( $t_{wait}$ ). The pin has an internal pullup.

**7.2.2.2 SCK - Synchronization Serial Clock**

The MCU uses SCK to synchronize communication. SCK is normally low, and the valid clock-pulse number is 16. At each falling edge, the MCU writes a new bit on the DIN input, and this IC writes a new bit on the DOUT output pin. At each rising edge, this IC reads the new bit on DIN, and the MCU reads the new bit on DOUT. The maximum clock frequency is 4 MHz. The pin has an internal pulldown.

**7.2.2.3 DIN - Serial Input Data**

DIN receives 16-bit data. The order of received bits is from the MSB (first) to the LSB (last). The pin has an internal pulldown. Update of the internal register with the received bits occurs only if the number of clock pulses is 16 while  $\overline{CS}$  is low.

**7.2.2.4 DOUT - Serial Output Data**

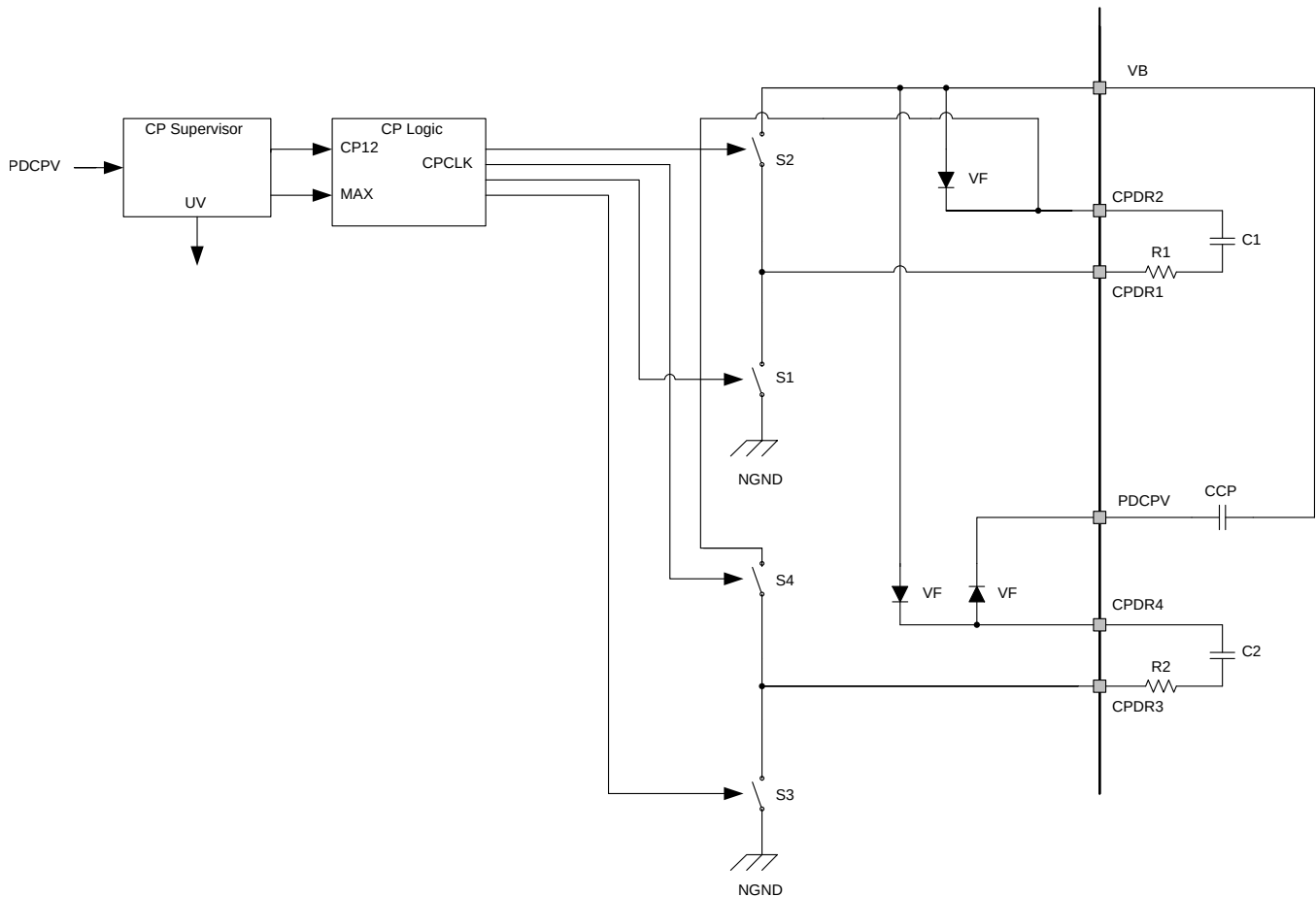
DOUT transmits 16-bit data. It is a three-state output, and it is in the high-impedance state when  $\overline{CS}$  is high. The order of serial data-bit transmission is from the MSB (first) to the LSB (last).



## Feature Description (continued)

### 7.2.3 Charge Pump

The charge-pump block generates a supply for the high-side and low-side pre-drivers to maintain the gate voltage on the external FETs. Use of an external storage capacitor (CCP) and bucket capacitors (C1, C2) supports pre-driver slope and switching-frequency requirements. R1 and R2 reduce switching current if required. The charge pump has voltage-supervisor functions such as over- and undervoltage, and selectable stop conditions for pre-drivers.



**Figure 10. Charge-Pump Block Diagram**

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### Feature Description (continued)

#### 7.2.4 Pre-Driver

The pre-driver block provides three high-side pre-drivers and three low-side pre-drivers to drive external N-channel MOSFETs. The turnon side of the high-side pre-drivers supplies the large N-channel transistor current for quick charge, and PMOS supports output voltages up to PDCPV. The turnoff side of the high-side pre-drivers supplies the large N-channel transistor current for quick discharge. The low-side pre-drivers supply the large N-channel transistor current for charge and discharge. VCP12 (created by a charge pump) controls the output voltage of the low-side pre-driver to output less than 18 V. The pre-driver has a stop condition in some fault conditions ([Fault Detection](#)) and SPI set ([Serial Port I/F](#)).

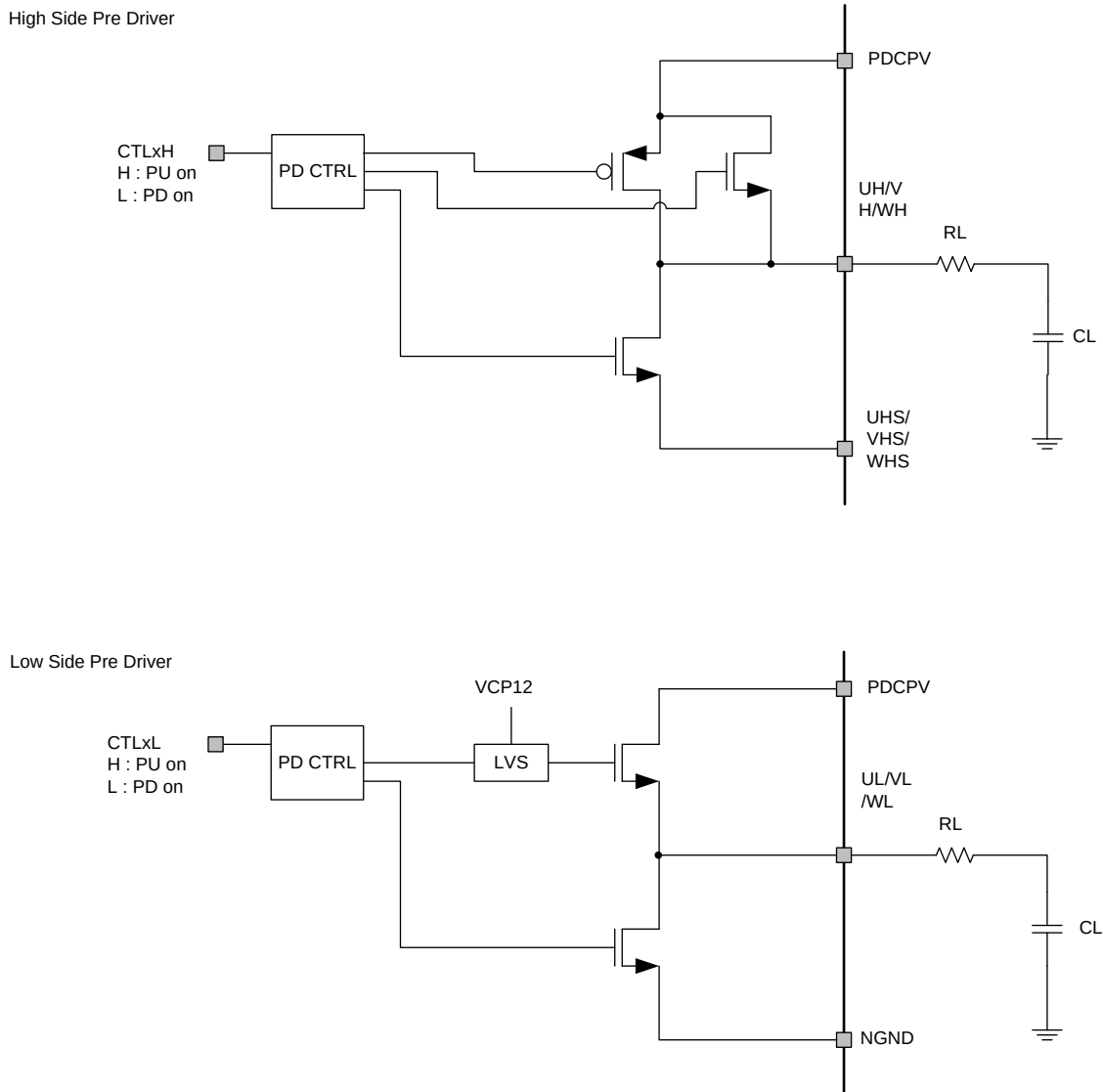
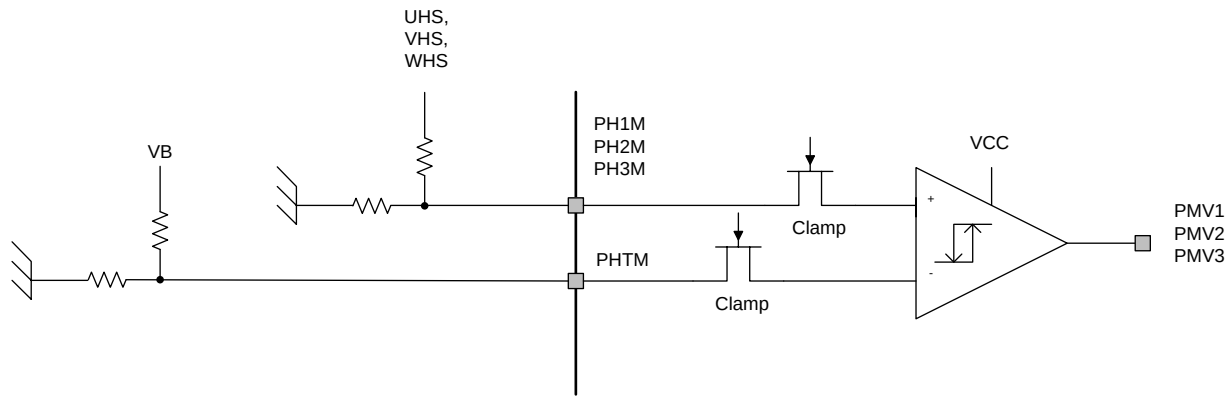


Figure 11. Pre-Driver Block Diagram

## Feature Description (continued)

### 7.2.5 Phase Comparator

The three-channel comparator module monitors the external FETs by detecting the drain-source voltage across the high-side and low-side FETs. PHTM is the threshold level of the comparators usable for sensorless communication. Figure 12 shows an example of the threshold level.



**Figure 12. Phase Comparator Block Diagram**

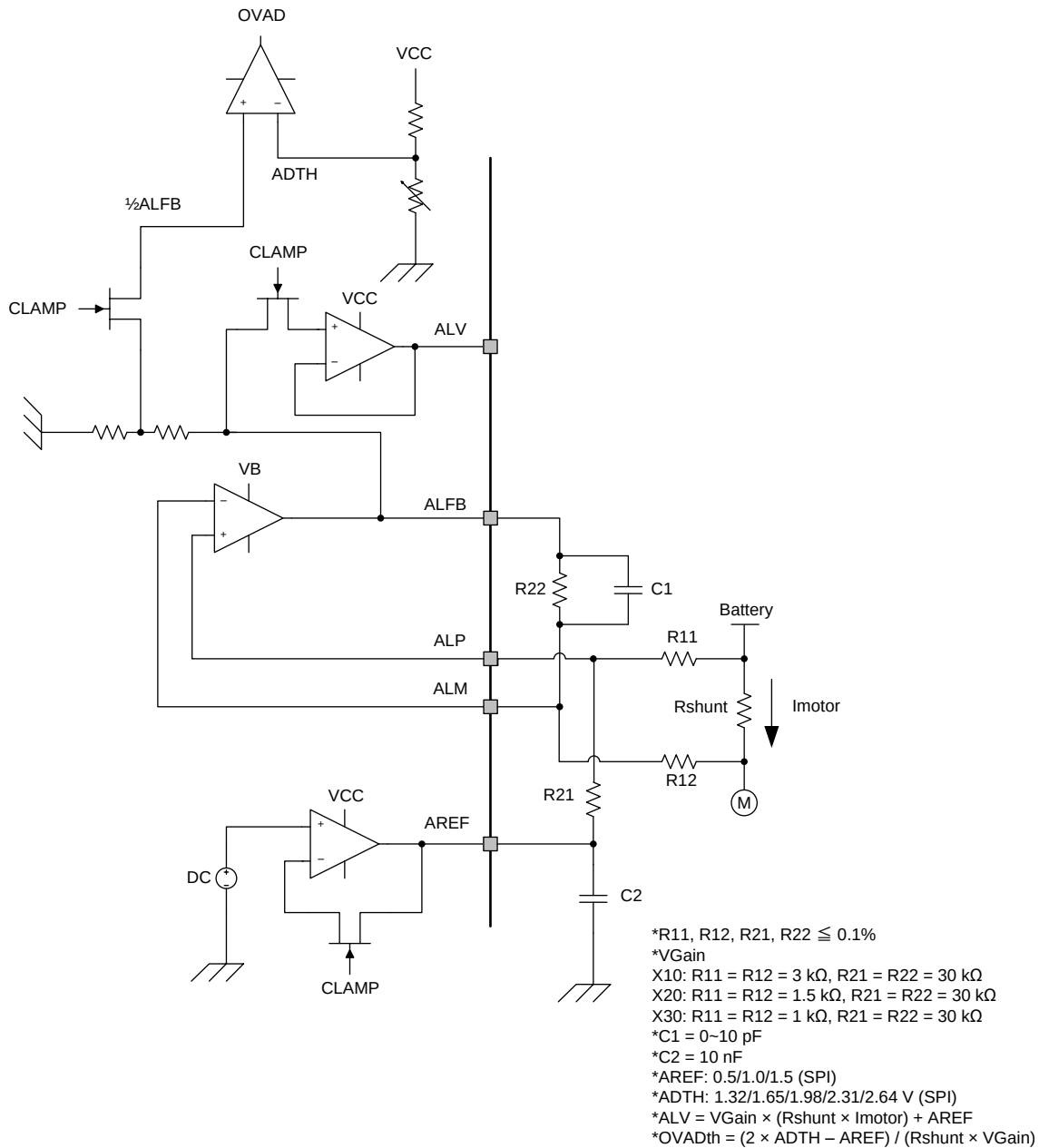
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**Feature Description (continued)****7.2.6 Motor-Current Sense**

The operational amplifier operates with an external resistor network for higher flexibility to adjust the current measurement to application requirements. The first-stage amplifier operates with the external resistor and the output voltage up to VB at ALFB. External resistors adjust the amplifier gain by 10 to 30 times. The second-stage amplifier is buffered to MCU at ALV. The current sense has a comparator for motor overcurrent (OVAD). ADTH is the overcurrent threshold level and is the value set by SPI. Figure 13 shows the curve of detection level. ALFB is divided by 2. Compare this value with ADTH. In recommended application, the zero-point adjustment is required as large error offset in initial condition.

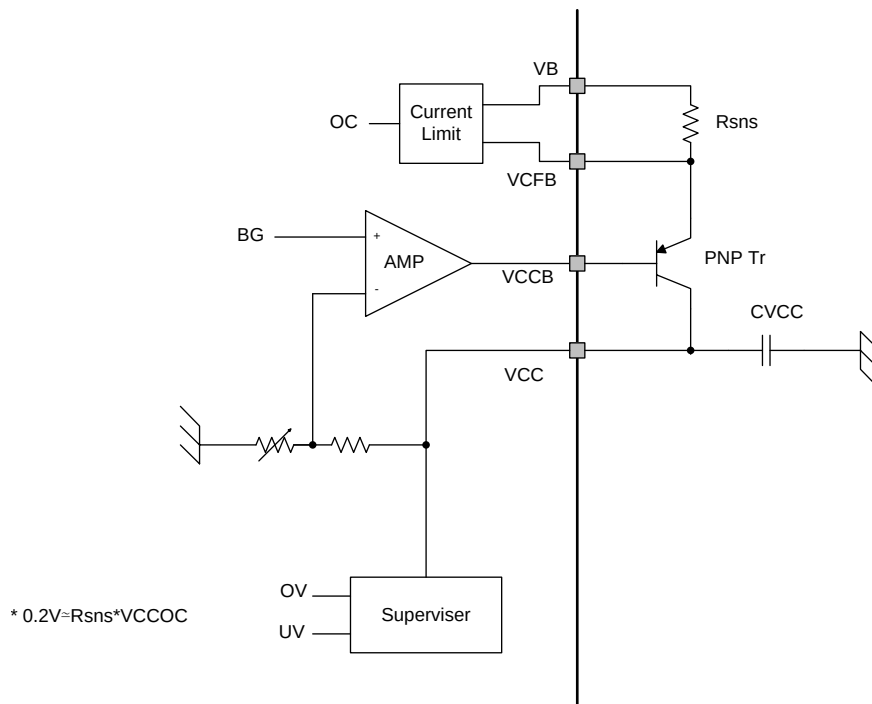
**Figure 13. Motor Current-Sense Block Diagram**

## Feature Description (continued)

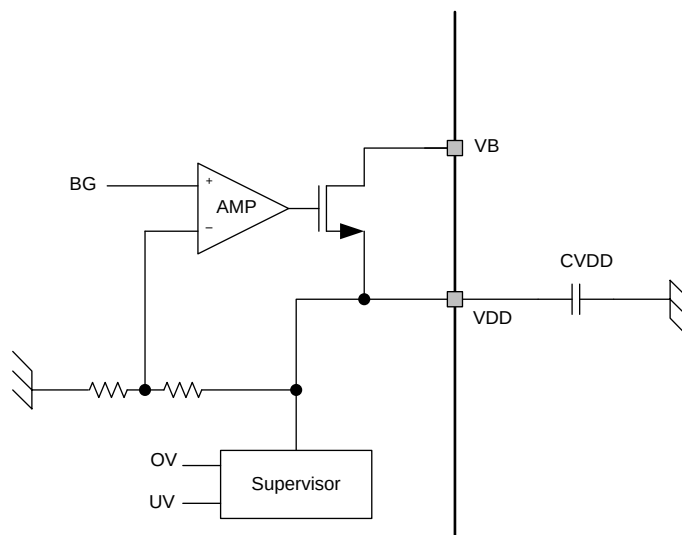
### 7.2.7 Regulators

The regulator block offers 3.3-V LDOs. The VCC LDO regulates VB down to 3.3 V with an external PNP controlled by the regulator block. This 3.3-V LDO is supplied to MCU and other components.

The VDD regulator regulates VB down to 3.3 V with internal FET and controller. The 3.3-V LDO with the external PNP is protected against short to GND fault. Overvoltage and undervoltage events of both supplies are detected. The under voltage of the 3.3-V LDO with the external PNP is set by SPI.



**Figure 14. VCC Block Diagram (External Driver)**



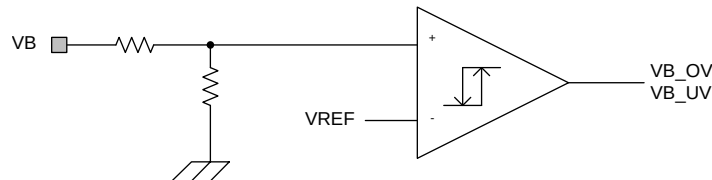
**Figure 15. VDD Block Diagram**

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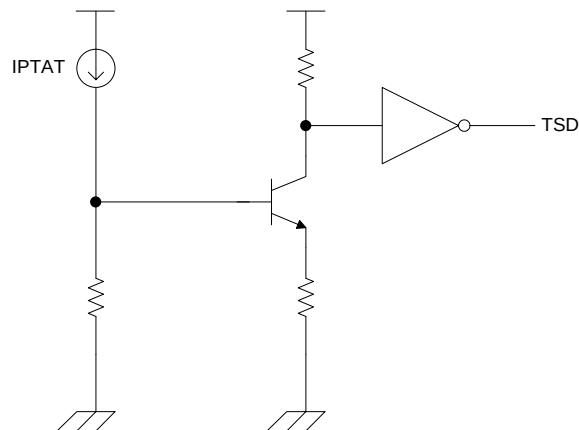
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[www.ti.com](http://www.ti.com)**Feature Description (continued)****7.2.8 VB Monitor**

The VB monitoring system has two comparators for under- and overvoltage, and has pre-driver stop-controlling system. Overvoltage provides a selectable pre-driver stop condition (SPI control), while undervoltage must stop pre-driver operation under detection (no selectable). The system should return to normal operation automatically after undetected level.

**Figure 16. VB Monitor Block Diagram****7.2.9 Thermal Shutdown**

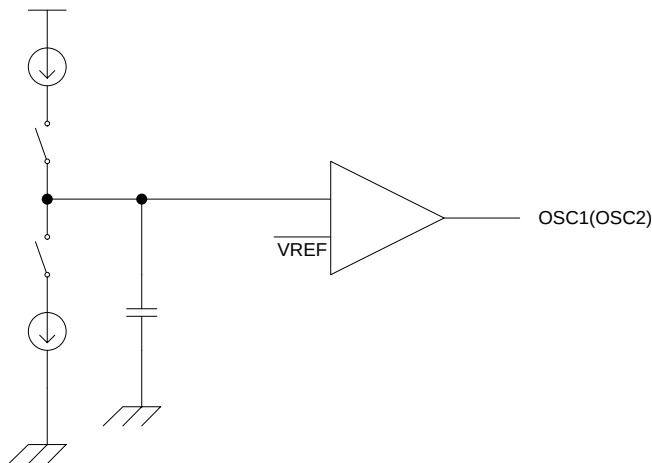
The device has temperature sensors that produce pre-driver stop condition if the chip temperature exceeds 175°C.

**Figure 17. Thermal Shutdown Block Diagram**

## Feature Description (continued)

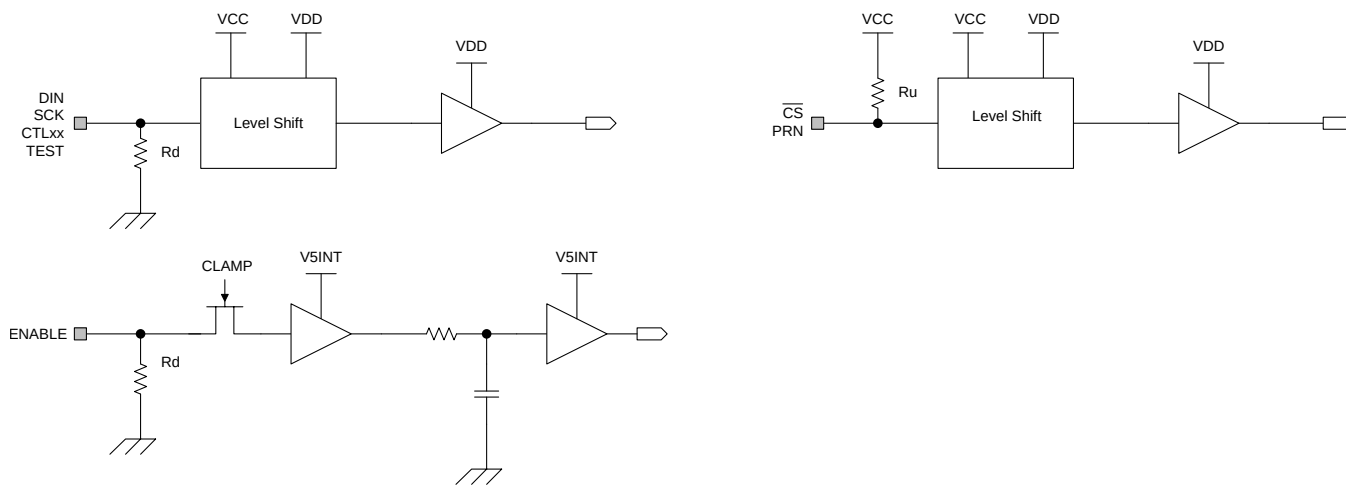
### 7.2.10 Oscillator

The oscillator block generates two 10-MHz clock signals. OSC1 is the primary clock used for internal logic-synchronization and timing control. OSC2 is the secondary clock used to monitor the status of OSC1.



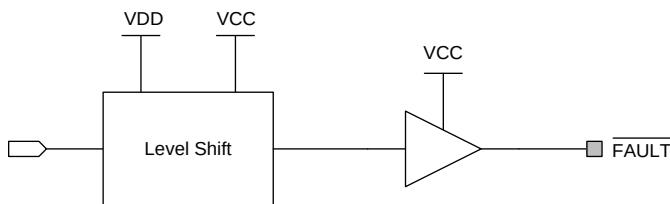
**Figure 18. Oscillator Block Diagram**

### 7.2.11 I/O



\* V5INT is the internal power supply.

**Figure 19. Input Buffer1 Block Diagram**

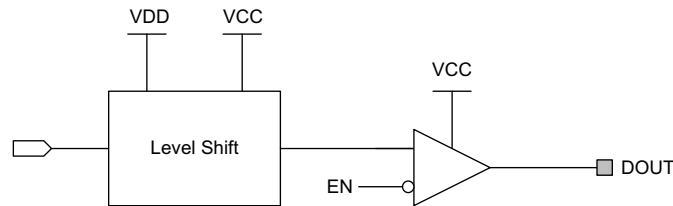
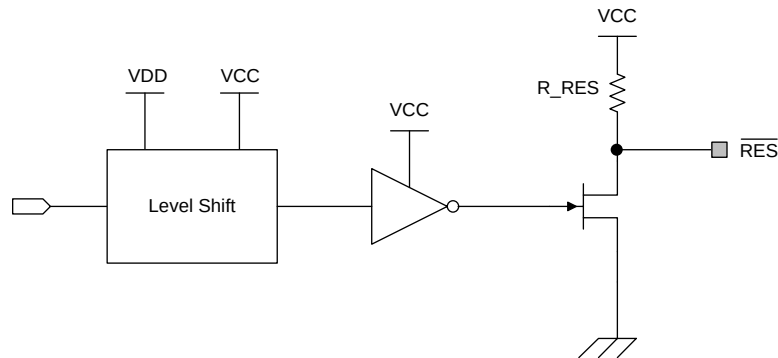


**Figure 20. Output Buffer1 Block Diagram**

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**Feature Description (continued)****Figure 21. Output Buffer2 Block Diagram****Figure 22. Output Buffer3 Block Diagram****Table 1. Recommended Pin Termination**

| PIN NAME | DESCRIPTION     | TERMINATION |
|----------|-----------------|-------------|
| TEST     | Test mode input | OPEN        |

**7.2.12 Fault Detection****Table 2. Fault Detection**

| ITEMS               | SPI FLTLFG | Pre Driver <sup>(1)</sup> | FAULT <sup>(2)</sup> | RES | Others                   |
|---------------------|------------|---------------------------|----------------------|-----|--------------------------|
| VB - Overvoltage    | VBOV       | Disable                   | L                    | H   |                          |
| VB - Undervoltage   | VBUV       | Disable                   | L                    | H   |                          |
| CP - Overvoltage    | CPOV       | Disable                   | L                    | H   |                          |
| CP - Undervoltage   | CPUV       | Disable                   | L                    | H   |                          |
| VCC - Overvoltage   | VCCOV      | Disable                   | L                    | H   |                          |
| VCC - Under Voltage | -          | Disable <sup>(3)</sup>    | H                    | L   |                          |
| VCC - Overcurrent   | VCCOC      | Disable                   | L                    | H   |                          |
| Motor - Overcurrent | MTOC       | Disable                   | L                    | H   |                          |
| VDD - Overvoltage   | VDDOV      | Disable                   | L                    | H   |                          |
| VDD - Undervoltage  | -          | Disable <sup>(3)</sup>    | H                    | L   |                          |
| Thermal shutdown    | TSD        | Disable                   | L                    | H   |                          |
| Watch Dog           | -          | -                         | H                    | L   |                          |
| Clock Monitor       | -          | -                         | H                    | L   |                          |
| SPI format error    | -          | -                         | H                    | H   | SPI serial out error bit |

(1) Pre-driver is disabled if the conditions occur and SDNEN register bits are 1.

(2) FAULT pin is asserted to low if the conditions occur and FLTEN register bits are 1.

(3) Pre-driver is disabled by VCC undervoltage and VDD undervoltage conditions regardless of SPI register setting.



## 7.3 Register Maps

**Table 3. SPI Serial Input Format**

|     | MSB     | D14     | D13     | D12     | D11     | D10     | D9      | D8      |
|-----|---------|---------|---------|---------|---------|---------|---------|---------|
| DIN | RW[1]   | RW[0]   | Addr[5] | Addr[4] | Addr[3] | Addr[2] | Addr[1] | Addr[0] |
|     | D7      | D6      | D5      | D4      | D3      | D2      | D1      | LSB     |
| DIN | Data[7] | Data[6] | Data[5] | Data[4] | Data[3] | Data[2] | Data[1] | Data[0] |

**Table 4. SPI Serial Output Data Format**

|      | MSB     | D14         | D13     | D12     | D11     | D10     | D9      | D8      |
|------|---------|-------------|---------|---------|---------|---------|---------|---------|
| DOUT | 0       | Frame fault | 0       | 0       | 0       | 0       | 0       | 1       |
|      | D7      | D6          | D5      | D4      | D3      | D2      | D1      | LSB     |
| DOUT | Data[7] | Data[6]     | Data[5] | Data[4] | Data[3] | Data[2] | Data[1] | Data[0] |

SPI serial input and output format

RW[1:0] : 01: write mode; 00: read mode

Addr[5:0] : Address of SPI access

Data[7:0] : Input data to write or output data to read

Frame fault : 0: No error exists in the previous SPI frame.

: 1: Error exists in the previous SPI frame.

**Table 5. SPI Register Map**

| Register Name | Addr (Hex) | b7          | b6       | b5       | b4       | b3      | b2       | b1           | b0      | Reset (Hex) |
|---------------|------------|-------------|----------|----------|----------|---------|----------|--------------|---------|-------------|
| Reserved      | 00         | RSVD        |          |          |          |         |          |              |         | 00          |
| CFGUNLK       | 01         | RSVD        |          |          |          | CFGUNLK |          |              |         | 00          |
| FLTCFG        | 02         | FLGLATCH_EN | MTOCTH   |          |          | RSVD    | VCCUVTH  | VBUVTH       |         | 00          |
| Reserved      | 03         | RSVD        |          |          |          |         |          |              |         | 00          |
| FLTEN0        | 04         | FE_MTOC     | FE_VCCOC | FE_VCCOV | FE_VDDOV | FE_CPOV | FE_CPUV  | FE_VBOV      | FE_VBUV | FF          |
| FLTEN1        | 05         | RSVD        |          |          |          |         |          |              | FE_TSD  | 01          |
| SDNEN0        | 06         | SE_MTOC     | SE_VCCOC | SE_VCCOV | SE_VDDOV | SE_CPOV | SE_CPUV  | SE_VBOV      | SE_VBUV | FF          |
| SDNEN1        | 07         | RSVD        |          |          |          |         |          |              | SE_TSD  | 01          |
| FLTFLG0       | 08         | MTOC        | VCCOC    | VCCOV    | VDDOV    | CPOV    | CPUV     | VBOV         | VBUV    | 00          |
| FLTFLG1       | 09         | RSVD        |          |          |          |         |          |              | TSD     | 00          |
| CSCFG         | 0A         | RSVD        |          |          |          |         | CSOFFSET |              |         | 00          |
| PDCFG         | 0B         | RSVD        |          |          |          |         |          | DEADT        |         | 00          |
| DIAG          | 0C         | RSVD        |          |          |          |         | VCCUVRST | WDTRST       | CMRST   | 00          |
| SPARE         | 0D         | SPARE       |          |          |          |         |          | SEL_COMP_HYS |         | 00          |
| Reserved      | 0E-3F      | RSVD        |          |          |          |         |          |              |         | 00          |

### 7.3.1 Register Descriptions

Access type: R = Read and W = Write.

Reserved register: Read of reserved bits return 0 and write has no effect.

#### 7.3.1.1 CFGUNLK (address 0x01): Configuration Unlock Register

| Bit | Name    | Type | Reset | Description                                                                                                                                                                                                                                                                                     |
|-----|---------|------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 3:0 | CFGUNLK | RW   | 0000  | DRV3203E-Q1 SPI register map has lock and unlock mode, and it is in lock mode by default. MCU can write values of the following registers in unlock mode; <ul style="list-style-type: none"> <li>• FLTCFG</li> <li>• FLTEN0 and FLTEN1</li> <li>• SDNEN0 and SDNEN1</li> <li>• CSCFG</li> </ul> |

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| Bit | Name | Type | Reset | Description                                                                                                                                                                                                                                                                                               |
|-----|------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|     |      |      |       | <ul style="list-style-type: none"> <li>• PDCFG</li> <li>• WDCFG</li> </ul> <p>In lock mode, read returns the values, but writing the registers have no effect.</p> <p>Device enters unlock mode by writing 0x5, 0x8, 0x7 to CFGUNLK register in series. Device exits from unlock mode by writing 0x0.</p> |

**7.3.1.2 FLTCFG (address 0x02): Fault Detection Configuration Register**

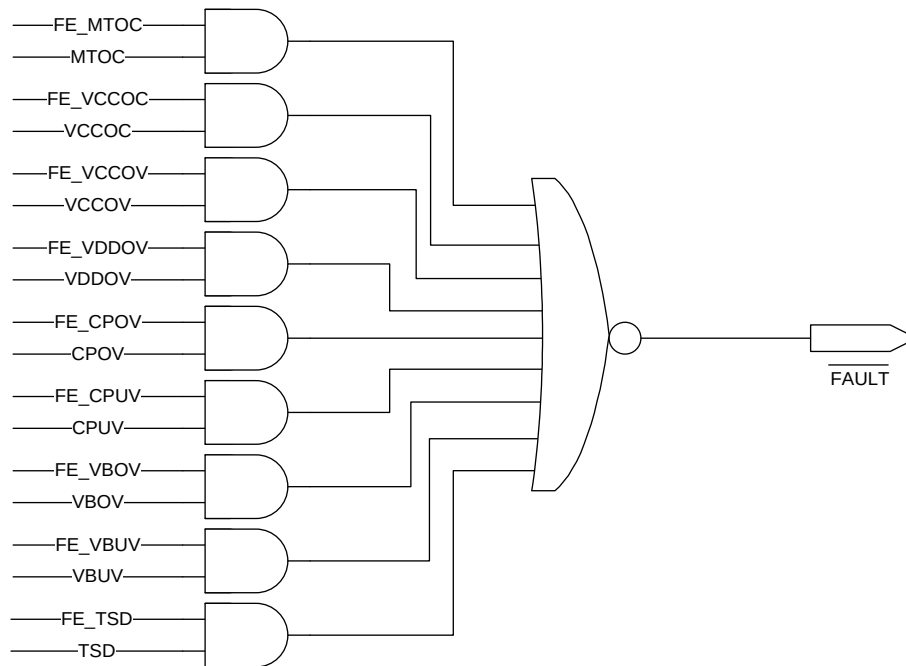
| Bit | Name        | Type | Reset | Description                                                                                                                                                                                                                    |
|-----|-------------|------|-------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | FLGLATCH_EN | RW   | 0     | <p>Fault-flag (FLTFLG*) latch enable</p> <p>0: Fault events do not latch fault-flag register bits.</p> <p>1: Latching of fault-flag register bits by the fault events occurs. The flag bits remain asserted until cleared.</p> |
| 6:4 | MTOCTH      | RW   | 000   | <p>Motor overcurrent detection threshold (ADTH)</p> <p>000: 1.32 V</p> <p>001: 1.65 V</p> <p>010: 1.98 V</p> <p>011: 2.31 V</p> <p>100: 2.64 V</p> <p>Others: 1.32 V</p>                                                       |
| 3   | RSVD        | R    | 0     | Reserved                                                                                                                                                                                                                       |
| 2   | VCCUVTH     | RW   | 0     | <p>VCC undervoltage detection threshold</p> <p>0: 2.2 V</p> <p>1: 2.4 V</p>                                                                                                                                                    |
| 1:0 | VBUVTH      | RW   | 00    | <p>VB undervoltage detection threshold</p> <p>00: 4 V</p> <p>01: 4.5 V</p> <p>10: 5 V</p> <p>11: 5.5 V</p>                                                                                                                     |

**7.3.1.3 FLTEN0 (address 0x04): FAULT Pin Enable Register 0**

| Bit | Name     | Type | Reset | Description                                                                                                                                                                                                                                             |
|-----|----------|------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | FE_MTOC  | RW   | 1     | <p>FAULT pin enable of FLTFLG0 register bits.</p> <p>0: Assertion of the FAULT pin does not occur when the fault flag bit is 1</p> <p>1: Assertion of the FAULT pin to low level occurs when the fault flag bit is 1. See <a href="#">Figure 23</a></p> |
| 6   | FE_VCCOC | RW   | 1     |                                                                                                                                                                                                                                                         |
| 5   | FE_VCCOV | RW   | 1     |                                                                                                                                                                                                                                                         |
| 4   | FE_VDDOV | RW   | 1     |                                                                                                                                                                                                                                                         |
| 3   | FE_CPOV  | RW   | 1     |                                                                                                                                                                                                                                                         |
| 2   | FE_CPUV  | RW   | 1     |                                                                                                                                                                                                                                                         |
| 1   | FE_VBOV  | RW   | 1     |                                                                                                                                                                                                                                                         |
| 0   | FE_VBUV  | RW   | 1     |                                                                                                                                                                                                                                                         |

**7.3.1.4 FLTEN1 (address 0x05): FAULT Pin Enable Register 1**

| Bit | Name   | Type | Reset    | Description                                                                                                                                                                                                                                 |
|-----|--------|------|----------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:1 | RSVD   | R    | 0000 000 | Reserved                                                                                                                                                                                                                                    |
| 0   | FE_TSD | RW   | 1        | <p>FAULT pin enable of TSD flag bit</p> <p>0: Assertion of the FAULT pin does not occur when the fault flag bit is 1</p> <p>1: Assertion of the FAULT pin to low level occurs when the TSD flag bit is 1. See <a href="#">Figure 23</a></p> |



**Figure 23. FAULT Pin Enable Logic**

#### 7.3.1.5 SDNEN0 (address 0x06): Pre-Driver Shutdown Enable Register 0

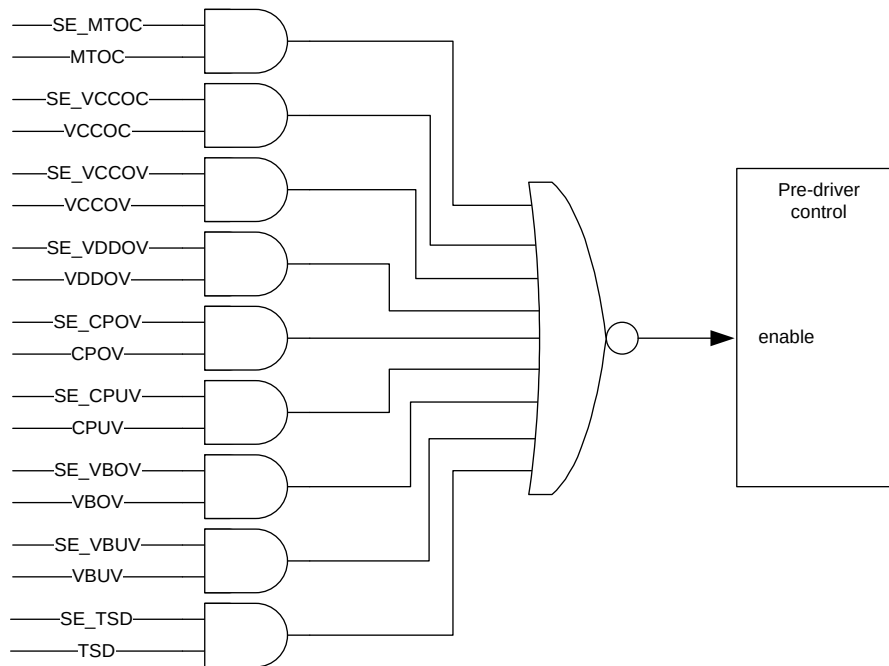
| Bit | Name     | Type | Reset | Description                                                                                                                                                                                                                                                                                                 |
|-----|----------|------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | SE_MTOC  | RW   | 1     | Pre-driver shutdown enable of FLTFLG0 register bits<br>0: Disabling of the pre-driver outputs does not occur when the fault flag bit is 1.<br>1: Disabling of the pre-driver outputs occurs when the fault flag bit is 1. Both the high-side and low-side FETs turn off.<br>See <a href="#">Figure 24</a> . |
| 6   | SE_VCCOC | RW   | 1     |                                                                                                                                                                                                                                                                                                             |
| 5   | SE_VCCOV | RW   | 1     |                                                                                                                                                                                                                                                                                                             |
| 4   | SE_VDDOV | RW   | 1     |                                                                                                                                                                                                                                                                                                             |
| 3   | SE_CPOV  | RW   | 1     |                                                                                                                                                                                                                                                                                                             |
| 2   | SE_CPUV  | RW   | 1     |                                                                                                                                                                                                                                                                                                             |
| 1   | SE_VBOV  | RW   | 1     |                                                                                                                                                                                                                                                                                                             |
| 0   | SE_VBUV  | RW   | 1     |                                                                                                                                                                                                                                                                                                             |

#### 7.3.1.6 SDNEN1 (address 0x07): Pre-Driver Shutdown Enable Register 1

| Bit | Name   | Type | Reset    | Description                                                                                                                                                                                                                                                                                     |
|-----|--------|------|----------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:1 | RSVD   | R    | 0000 000 | Reserved                                                                                                                                                                                                                                                                                        |
| 0   | SE_TSD | RW   | 1        | Pre-driver shutdown enable of TSD flag bits<br>0: Disabling of the pre-driver outputs does not occur when the TSD flag bit is 1.<br>1: Disabling of the pre-driver outputs occurs when the TSD flag bit is 1. Both the high-side and low-side FETs turn off.<br>See <a href="#">Figure 24</a> . |

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[www.ti.com](http://www.ti.com)**Figure 24. Pre-Driver Shutdown Logic****7.3.1.7 FLTFLG0 (address 0x08): Fault Flag Register 0**

| Bit | Name  | Type <sup>(1)</sup> | Reset | Description                                                                  |
|-----|-------|---------------------|-------|------------------------------------------------------------------------------|
|     |       |                     |       | Fault flag bits of the following conditions; <sup>(2)</sup>                  |
| 7   | MTOC  | RW                  | 0     | MTOC: Motor overcurrent. (OVAD)                                              |
| 6   | VCCOC | RW                  | 0     | VCCOC: VCC overcurrent                                                       |
| 5   | VCCOV | RW                  | 0     | VCCOV: VCC overvoltage                                                       |
| 4   | VDDOV | RW                  | 0     | VDDOV: VDD overvoltage                                                       |
| 3   | CPOV  | RW                  | 0     | CPOV: Charge-pump overvoltage                                                |
| 2   | CPUV  | RW                  | 0     | CPUV: Charge-pump undervoltage                                               |
| 1   | VBOV  | RW                  | 0     | VBOV: VB overvoltage                                                         |
| 0   | VBUV  | RW                  | 0     | VBUV: VB undervoltage                                                        |
|     |       |                     |       | If FLTCFG.FLGLATCH_EN = 1                                                    |
|     |       |                     |       | 0: Read = No fault condition exists since last cleared.<br>Write = No effect |
|     |       |                     |       | 1: Read = Fault condition exists.<br>Write = Clear the flag.                 |
|     |       |                     |       | If FLTCFG.FLGLATCH_EN = 0                                                    |
|     |       |                     |       | 0: Read = No fault condition<br>Write = No effect                            |
|     |       |                     |       | 1: Read = Fault condition<br>Write = No effect                               |

(1) R: Read, W: Write

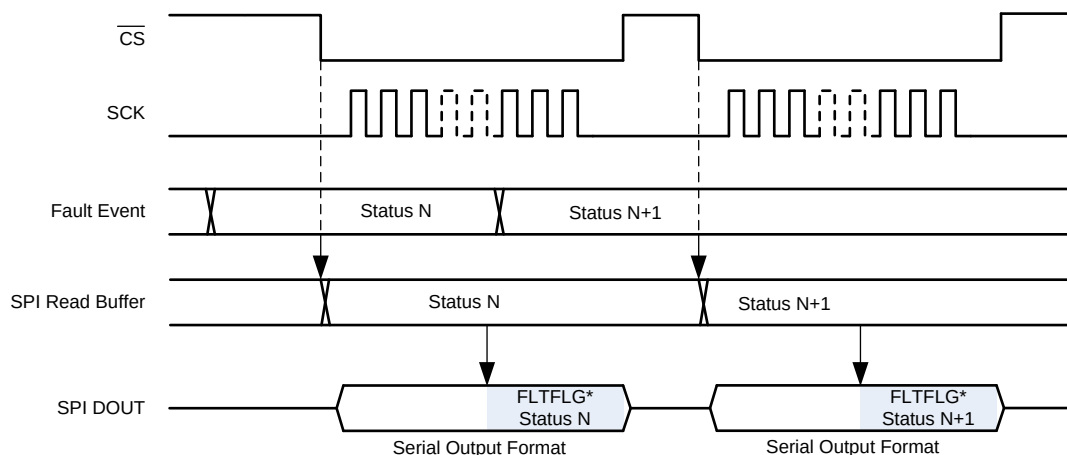
(2) Assertion of the fault flags may occur during power up.

### 7.3.1.8 FLGFLT1 (address 0x09): Fault Flag Register 1

| Bit | Name | Type <sup>(1)</sup> | Reset       | Description                                                                                                                                                                                                                                                                                                                                                                                                    |
|-----|------|---------------------|-------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:1 | RSVD | R                   | 0000<br>000 | Reserved                                                                                                                                                                                                                                                                                                                                                                                                       |
| 0   | VBUV | RW                  | 1           | <p>Fault flag bit of thermal shutdown condition.<sup>(2)</sup></p> <p>If FLTCFG.FLGLATCH_EN = 1</p> <p>0: Read = No fault condition exists since last cleared.<br/>Write = No effect</p> <p>1: Read = Fault condition exists.<br/>Write = Clear the flag</p> <p>If FLTCFG.FLGLATCH_EN = 0</p> <p>0: Read = No fault condition<br/>Write = No effect</p> <p>1: Read = Fault condition<br/>Write = No effect</p> |

(1) R: Read, W: Write

(2) Assertion of the fault flags may occur during power up.

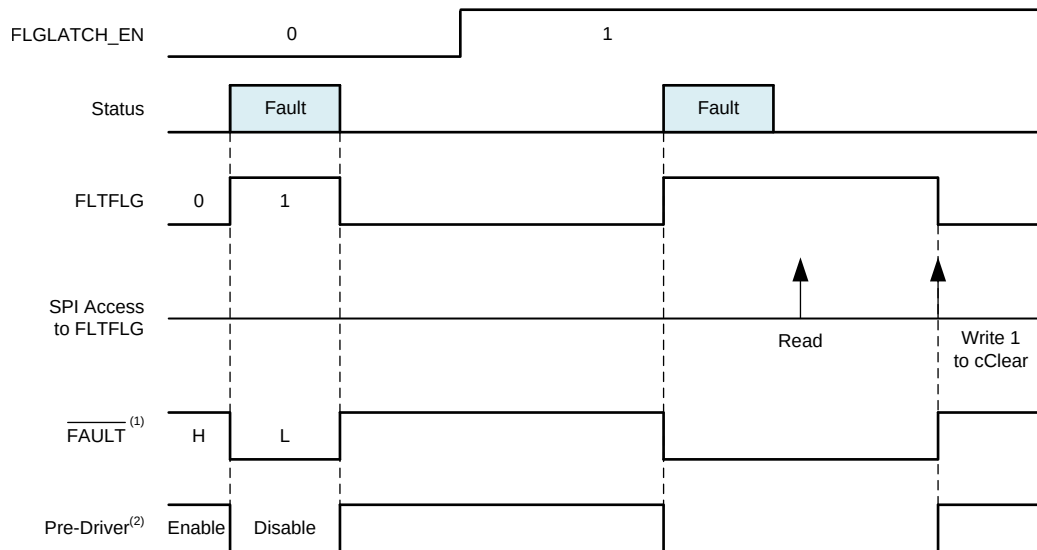


**Figure 25. SPI Data-Out Timing Chart of Fault Flag Registers**

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(1) Assertion of  $\overline{\text{FAULT}}$  occurs if  $\text{FLTEN} = 1$ .(2) Disabling of pre-driver occurs if  $\text{SDNEN} = 1$ .**Figure 26. FLGFLG and FLGLATCH\_EN****7.3.1.9 CSCFG (address 0x0A): Current Sense Configuration Register**

| Bit | Name     | Type <sup>(1)</sup> | Reset  | Description                                                                   |
|-----|----------|---------------------|--------|-------------------------------------------------------------------------------|
| 7:3 | RSVD     | R                   | 0000 0 | Reserved                                                                      |
| 2:0 | CSOFFSET | RW                  | 000    | Current-sense offset<br>000: 0.5 V<br>001: 1 V<br>010: 1.5 V<br>Others: 0.5 V |

(1) R: Read W: Write

**7.3.1.10 PDCFG (address 0x0B): Pre-Driver Configuration Register**

| Bit | Name  | Type <sup>(1)</sup> | Reset   | Description                                                                                                                                                                                                                     |
|-----|-------|---------------------|---------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:2 | RSVD  | R                   | 0000 00 | Reserved                                                                                                                                                                                                                        |
| 1:0 | DEADT | RW                  | 00      | Dead time (= $t_{\text{dead}}$ )<br>00: 2.1 $\mu\text{s}$<br>01: 1.6 $\mu\text{s}$<br>10: 1.1 $\mu\text{s}$<br>11: 0.6 $\mu\text{s}$<br>The actual dead time has $\pm 0.1\text{-}\mu\text{s}$ variation from the typical value. |

(1) R: Read W: Write

**7.3.1.11 DIAG (address 0x0C): Diagnosis Register**

| Bit | Name     | Type | Reset  | Description                                                                                                                                                                   |
|-----|----------|------|--------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:3 | RSVD     | R    | 0000 0 | Reserved                                                                                                                                                                      |
| 2   | VCCUVRST | R    | 0      | nRES reset source information<br>Bit 2 = VCCUVRST - VCC undervoltage<br>Bit 1 = WDTRST - watchdog timer<br>Bit 0 = CMRST - clock monitor<br>0: Read = Reset has not occurred. |
| 1   | WDTRST   | R    | 0      |                                                                                                                                                                               |
| 0   | CMRST    | R    | 0      |                                                                                                                                                                               |

| Bit | Name | Type | Reset | Description                                                                                                                                                                           |
|-----|------|------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|     |      |      |       | <p>Write = No effect</p> <p>1: Read = A corresponding reset source caused the last reset condition.</p> <p>Write = No effect</p> <p>Read access to this register clears the bits.</p> |

### 7.3.1.12 SPARE (address 0x0D): Spare Register

| Bit | Name         | Type <sup>(1)</sup> | Reset      | Description                                                                                                                                                  |
|-----|--------------|---------------------|------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:2 | SPARE        | RW                  | 0000<br>00 | Spare registers for future use. Read and write have no effect.                                                                                               |
| 1:0 | SEL_COMP_HYS | RW                  | 00         | <p>Select phase comparator hysteresis voltage. The following show the typical values.</p> <p>00: 0 V</p> <p>01: 25 mV</p> <p>10: 50 mV</p> <p>11: 100 mV</p> |

(1) R: Read W: Write

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

[illegible]

Product Folder Links: [DRV3203E-Q1](#)



## 9 Device and Documentation Support

### 9.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 9.2 Community Resources

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### 9.4 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### 9.5 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 10 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|---------|
| DRV3203EPHPRQ1   | OBSOLETE      | HTQFP        | PHP                | 48   |                | TBD             | Call TI                              | Call TI              |              | DRV3203E                |         |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

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**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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## GENERIC PACKAGE VIEW

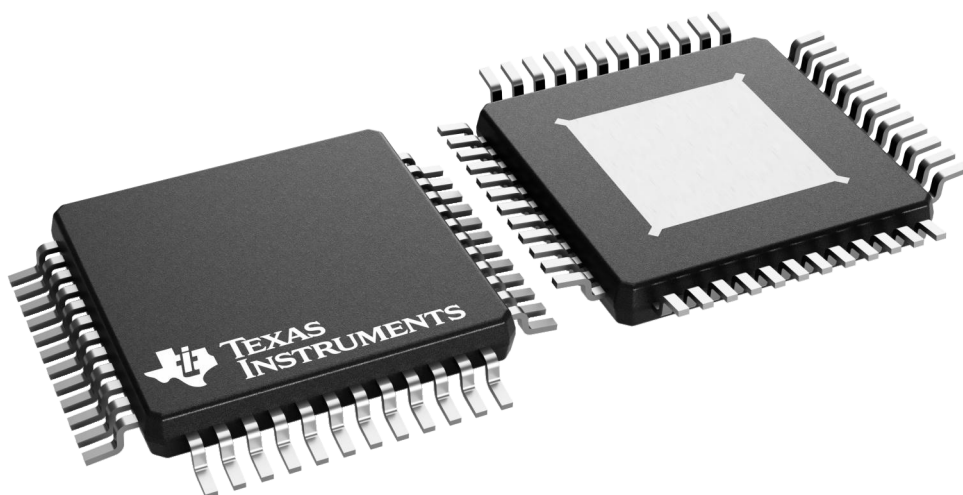
**PHP 48**

**TQFP - 1.2 mm max height**

7 x 7, 0.5 mm pitch

QUAD FLATPACK

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.



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